

M.E. VLSI DESIGN

Controller of Examinations
Government College of Technology
COIMBATORE - 641 013

VLSI DESIGN

VISION OF THE INSTITUTION

To emerge as a centre of excellence and eminence by imparting futuristic technical education in keeping with global standards, making our students technologically competent and ethically strong so that they can readily contribute to the rapid advancement of society and mankind.

MISSION OF THE INSTITUTION

- To achieve Academic excellence through innovative teaching and learning practices.
- To enhance employability and entrepreneurship.
- To improve the research competence to address societal needs.
- To inculcate a culture that supports and reinforces ethical, professional behaviours for a harmonious and prosperous society.

VISION OF THE DEPARTMENT

The vision of ECE department is to become pioneer in higher learning and research and to produce creative solution to societal needs.

MISSION OF THE DEPARTMENT

1. To provide excellence in education, research and public service.
2. To provide quality education and to make the students entrepreneur and employable.
3. Continuous upgradation of techniques for reaching heights of excellence in a global perspectives.

PROGRAM OUTCOMES

Ability to

1. Acquire in-depth knowledge in the field of VLSI Design with an ability to evaluate and analyse the existing knowledge for enhancement
2. Analyse critical complex engineering problems and provide solutions through research
3. Identity the areas for the development of Electronic hardware design for the benefit of the society
4. Extract information pertinent to challenging problems through literature survey and by applying appropriate research methodologies, techniques and tools to the development of technological knowledge
5. Select, learn and apply appropriate techniques, resources and modern engineering tools to complex engineering activities with an understanding of limitations

6. Understand group dynamics, recognise opportunities and contribute positively to multidisciplinary work to achieve common goals for further learning
7. Demonstrate engineering principles and apply the same to manage projects efficiently as a team after considering economical and financial factors
8. Communicate with engineering community and society regarding complex engineering activities effectively through reports, design documentation and presentations
9. Engage with commitment in life-long learning independently to improve knowledge and competence
10. Acquire professional and intellectual integrity, professional code and conduct, ethics of research and scholarship by considering the research outcomes to the community for sustainable development of society
11. Observe and examine critically the outcomes and make corrective measures, and learn from mistakes without depending on external feedback

PROGRAM EDUCATIONAL OBJECTIVES:

1. Acquire indepth knowledge, analyse and solve complex problems through research in the field of electronics after considering public health, safety, cultural and societal needs
2. Apply the acquired research skills using modern tools and techniques to solve the challenging problems in multidisciplinary areas
3. Apply the learnt engineering principles for project and finance management and communicate with society effectively
4. Acquire professional and intellectual integrity, ethics of research for sustainable development of society through independent and lifelong learning

**Controller of Examinations
Government College of Technology
COIMBATORE - 641 013**

**CHOICE BASED CREDIT SYSTEM
CURRICULUM FOR CANDIDATES ADMITTED
DURING 2016 ONWARDS
BRANCH: M.E.(VLSI DESIGN)-FULL TIME**

M.E. VLSI DESIGN

2016 REGULATIONS

FIRST SEMESTER

Sl. No.	Course Code	Course Title	Category	Continuous Assessment Marks	End Sem Marks	Total Marks	Credits			
							L	T	P	C
		THEORY								
1	16VLFC01	Applied Mathematics	FC	50	50	100	3	2	0	4
2	16VLPC01	Advanced Digital System Design	PC	50	50	100	3	0	0	3
3	16VLPC02	Digital CMOS VLSI Design	PC	50	50	100	3	0	0	3
4	16VLPC03	VLSI Design automation	PC	50	50	100	3	0	0	3
5		Professional Elective – I	PE	50	50	100	3	0	0	3
		PRACTICAL								
6	16VLPC04	VLSI Design Laboratory	PC	50	50	100	0	0	4	2
		TOTAL		300	300	600	15	2	4	18

SECOND SEMESTER

Sl. No.	Course Code	Course Title	Category	Continuous Assessment Marks	End Sem Marks	Total Marks	Credits			
							L	T	P	C
		THEORY								
1	16VLPC05	Analog VLSI	PC	50	50	100	3	0	0	3
2	16VLPC06	Low Power VLSI Design	PC	50	50	100	3	0	0	3
3	16VLPC07	VLSI Signal Processing	PC	50	50	100	3	0	0	3
4	16VLPC08	ASIC Design	PC	50	50	100	3	0	0	3
5		Professional Elective - II	PE	50	50	100	3	0	0	3
6		Professional Elective - III	PE	50	50	100	3	0	0	3
		PRACTICAL								
7	16VLPC09	System Level Design Laboratory	PC	50	50	100	0	0	4	2
		TOTAL		350	350	700	18	0	4	20

Controller of Examinations
Government College of Technology
COIMBATORE - 641 013

THIRD SEMESTER

Sl. No.	Course Code	Course Title	Category	Continuous Assessment Marks	End Sem Marks	Total Marks	Credits			
							L	T	P	C
		THEORY								
1		Professional Elective - IV	PE	50	50	100	3	0	0	3
2		Professional Elective - V	PE	50	50	100	3	0	0	3
3		Professional Elective - VI	PE	50	50	100	3	0	0	3
		PRACTICAL								
4	16VLEE01	Project Phase I	EEC	100	100	200	0	0	12	6
		TOTAL		250	250	500	9	0	12	15

FOURTH SEMESTER

Sl. No.	Course Code	Course Title	Category	Continuous Assessment Marks	End Sem Marks	Total Marks	Credits			
							L	T	P	C
		PRACTICAL								
1	16VLEE02	Project Phase II	EEC	200	200	400	0	0	24	12
		TOTAL		200	200	400	0	0	24	12

Controller of Examinations
Government College of Technology
COIMBATORE - 641 013

**CURRICULUM FOR CANDIDATES ADMITTED
DURING 2016 ONWARDS
BRANCH: M.E.(VLSI DESIGN)-PART TIME**

M.E. VLSI DESIGN

2016 REGULATION

FIRST SEMESTER

Sl. No.	Course Code	Course Title	Category	Continuous Assessment Marks	End Sem Marks	Total Marks	Credits			
							L	T	P	C
		THEORY								
1	16VLFC01	Applied Mathematics	FC	50	50	100	3	2	0	4
2	16VLPC01	Advanced Digital System Design	PC	50	50	100	3	2	0	4
3	16VLPC02	Digital CMOS VLSI Design	PC	50	50	100	3	0	0	3
		TOTAL		150	150	300	9	4	0	11

SECOND SEMESTER

Sl. No.	Course Code	Course Title	Category	Continuous Assessment Marks	End Sem Marks	Total Marks	Credits			
							L	T	P	C
		THEORY								
1	16VLPC05	Analog VLSI	PC	50	50	100	3	0	0	3
2	16VLPC06	Low Power VLSI	PC	50	50	100	3	0	0	3
3	16VLPC07	VLSI Signal Processing	PC	50	50	100	3	0	0	3
		TOTAL		150	150	300	9	0	0	9

THIRD SEMESTER

Sl. No.	Course Code	Course Title	Category	Continuous Assessment Marks	End Sem Marks	Total Marks	Credits			
							L	T	P	C
		THEORY								
1	16VLPC03	VLSI Design automation	PC	50	50	100	3	0	0	3
2		Professional Elective - I	PE	50	50	100	3	0	0	3
		PRACTICAL								
3	16VLPC04	VLSI Design Laboratory	PC	50	50	100	0	0	4	2
		TOTAL		150	150	300	6	0	4	8

FOURTH SEMESTER

Sl. No.	Course Code	Course Title	Category	Continuous Assessment Marks	End Sem Marks	Total Marks	Credits			
							L	T	P	C
		THEORY								
1	16VLPC08	ASIC Design	PC	50	50	100	3	0	0	3
2		Professional Elective - II	PE	50	50	100	3	0	0	3
3		Professional Elective - III	PE	50	50	100	3	0	0	3
		PRACTICAL								
4	16VLPC09	System Level Design Laboratory	PC	50	50	100	0	0	4	2
		TOTAL		200	200	400	9	0	4	11

FIFTH SEMESTER

Sl. No.	Course Code	Course Title	Category	Continuous Assessment Marks	End Sem Marks	Total Marks	Credits			
							L	T	P	C
		THEORY								
1		Professional Elective - IV	PE	50	50	100	3	0	0	3
2		Professional Elective - V	PE	50	50	100	3	0	0	3
3		Professional Elective - VI	PE	50	50	100	3	0	0	3
		PRACTICAL								
4	16VLEE01	Project Phase I	EEC	100	100	200	0	0	12	6
		TOTAL		250	250	500	9	0	12	15

SIXTH SEMESTER

Sl. No.	Course Code	Course Title	Category	Continuous Assessment Marks	End Sem Marks	Total Marks	Credits			
							L	T	P	C
		PRACTICAL								
1	16VLEE02	Project Phase II	EEC	200	200	400	0	0	24	12
		TOTAL		200	200	400	0	0	24	12

Controller of Examinations
 Government College of Technology
 COIMBATORE - 641 013

LIST OF PROFESSIONAL ELECTIVES

Sl. No.	Course Code	Course Title	Category	Continuous Assessment Marks	End Sem Marks	Credits			
						L	T	P	C
1	16VLPE01	Image and Video Processing	50	50	100	3	0	0	3
2	16VLPE02	Mixed Signal Circuits and Interfacing	50	50	100	3	0	0	3
3	16VLPE03	RF system Design	50	50	100	3	0	0	3
4	16VLPE04	Microsensors and MEMS	50	50	100	3	0	0	3
5	16VLPE05	Graph Theory and Optimization Techniques	50	50	100	3	0	0	3
6	16VLPE06	Neural Networks	50	50	100	3	0	0	3
7	16VLPE07	Electronic Packaging Technologies	50	50	100	3	0	0	3
8	16VLPE08	Nano electronics	50	50	100	3	0	0	3
9	16VLPE09	Real Time Operating System	50	50	100	3	0	0	3
10	16VLPE10	Embedded controllers	50	50	100	3	0	0	3
11	16VLPE11	High performance computer networks	50	50	100	3	0	0	3
12	16VLPE12	Analysis and Design of Analog Integrated Circuits.	50	50	100	3	0	0	3
13	16VLPE13	DSP Integrated Circuits	50	50	100	3	0	0	3
14	16VLPE14	Hardware software co-design	50	50	100	3	0	0	3
15	16VLPE15	Design of semiconductor memories	50	50	100	3	0	0	3
16	16VLPE16	System on chip	50	50	100	3	0	0	3
17	16VLPE17	Reconfigurable architecture for VLSI	50	50	100	3	0	0	3
18	16VLPE18	VLSI interconnects and its design techniques	50	50	100	3	0	0	3
19	16VLPE19	VLSI for wireless communication	50	50	100	3	0	0	3
20	16VLPE20	Testing and testability	50	50	100	3	0	0	3

LIST OF ONE CREDIT COURSE

Sl. No.	Course Code	Course Title	Category	Continuous Assessment Marks	End Sem Marks	Credits			
						L	T	P	C
1	16VLOC01	Seminar and Technical Writing	50	50	100	0	0	2	1

CREDIT SUMMARY- VLSI DESIGN -FULL TIME

S.No.	Subject Area	Credits per Semester				Credits Total	% of Total Credits	Total No. of Courses
		I	II	III	IV			
1	FC	4	-	-	-	4	6	1
2	PC	11	14	-	-	25	39	9
3	PE	3	6	9	-	18	28	6
4	EEC	-	-	6	12	18	28	2
	TOTAL	18	20	15	12	65		

FC – Foundation Course

PC-Professional Core

PE-Professional Elective

EEC-Employment Enhancement Course

CREDIT SUMMARY- VLSI DESIGN -PART TIME

S.No.	Subject Area	Credits per Semester						Credits Total	% of Total Credits	Total No. of Courses
		I	II	III	IV	V	VI			
1	FC	4	-	-	-	-	-	4	6	1
2	PC	6	9	5	5	-	-	25	39	9
3	PE	-	-	3	6	9	-	18	28	6
4	EEC	-	-	-	-	6	12	18	28	2
	TOTAL	10	9	8	11	15	12	65		

FC – Foundation Course

PC-Professional Core

PE-Professional Elective

EEC-Employment Enhancement Course

Controller of Examinations
Government College of Technology
COIMBATORE - 641 013

DEPARTMENT OF ECE VLSI DESIGN				
16VLFC01 APPLIED MATHEMATICS (Common to Applied Electronics)	L 3	T 2	P 0	C 4
CORE/ ELECTIVE COURSE: Core				
PREREQUISITES: <ul style="list-style-type: none"> Basics of algebra, differential and integral formulae. 				
COURSE ASSESSMENT METHODS: Both continuous and semester-end assessment.				
COURSE OBJECTIVES: <ul style="list-style-type: none"> To acquire knowledge of solving problems on matrix theory, discrete and continuous distributions. To develop an understanding of discrete and continuous random processes. To acquire knowledge of linear programming problems. To familiarize with queuing models. 				
COURSE OUTCOMES: Upon completion of this course, the students will have an ability to: <p>CO1:Gain the skill of finding eigen values using QR algorithm and the knowledge of discrete and continuous distributions along with functions of random variables.</p> <p>CO2:Develop discrete and continuous random processes including Markov processes and also solutions of Linear Programming problems.</p> <p>CO3:Understand probability values for various queuing models in situations of single or many service terminals available.</p>				
TOPICS COVERED:				
LINEAR ALGEBRA		(9+6)		
Vector spaces – norms – Inner Products – Eigenvalues using QR transformations – QR factorization - generalized eigenvectors– singular value decomposition and applications - pseudo inverse – least square approximations –Toeplitz matrices and some applications.				
ONE DIMENSIONAL RANDOM VARIABLES		(9+6)		
Random variables - Probability function – moments – moment generating functions and their properties – Binomial, Poisson, Geometric, Uniform, Exponential, Gamma and Normal distributions – Function of a Random Variable.				
RANDOM PROCESSES		(9+6)		
Classification – Auto correlation - Cross correlation - Stationary random process – Markov process – Markov chain - Poisson process – Gaussian process.				
LINEAR PROGRAMMING		(9+6)		

Formulation – Graphical solution – Simplex method – Two phase method - Transportation and Assignment Models.

QUEUEING MODELS

(9+6)

Characteristic and representation of queuing models- Model I: [(M/M/1): (/FIFO)], Model II: [(M/M/S): (/FIFO)], Model III: [(M/M/1): (N/FIFO)], Model IV: [(M/M/S): (N/FIFO)].

LECTURE: 45 PERIODS TUTORIAL: 30 PERIODS PRACTICAL: 0 PERIODS TOTAL: 75 PERIODS

Reference Books:

1. Bronson, R. *Matrix Operation, Schaum's outline series, McGraw Hill, New York (1989).*
2. Oliver C. Ibe, *"Fundamentals of Applied Probability and Random Processes, Academic Press, (An imprint of Elsevier), 2010.*
3. Taha H.A. *"Operations Research: An introduction" Ninth Edition, Pearson Education, Asia, New Delhi 2012.*
4. Sankara Rao, K. *"Introduction to partial differential equations" Prentice Hall of India, Pvt, Ltd, New Delhi, 1997.*
5. Andrews, L.C. and Philips. R. L. *"Mathematical Techniques for engineering and scientists", Printice Hall of India, 2006.*
6. O'Neil P.V. *"Advanced Engineering Mathematics", (Thomson Asia Pvt Ltd, Singapore) 2007, Cengage Learning India Private Limited..*

	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11
CO1	1	-	-	1	2	-	-	-	1	-	-
CO2	-	3	-	1	-	-	-	-	1	-	-
CO3	1	-	-	1	2	-	-	-	1	-	-

Controller of Examinations
Government College of Technology
COIMBATORE - 641 013

16VLPC01 ADVANCED DIGITAL SYSTEM DESIGN (Common to Applied Electronics)	L 3	T 0	P 0	C 3
CORE/ ELECTIVE COURSE: Core				
PREREQUISITES:				
<ul style="list-style-type: none"> Digital Electronics, Programmable devices. 				
COURSE ASSESSMENT METHODS: Both continuous and semester-end assessment.				
COURSE OBJECTIVES:				
<ul style="list-style-type: none"> To get knowledge on Verilog HDL programming and ability to design digital systems. To design and analyze the clocked synchronous and asynchronous sequential Circuits. To get knowledge on Fault diagnosis and Testability algorithms. 				
COURSE OUTCOMES:				
<p>Upon completion of the course, the students will have:</p> <p>CO1: Knowledge on Verilog HDL programming and ability to design digital systems.</p> <p>CO2: Ability to design and analyze the clocked synchronous and asynchronous sequential Circuits.</p> <p>CO3: Knowledge on Fault diagnosis and Testability algorithms.</p>				
TOPICS COVERED:				
SYSTEM DESIGN USING VERILOG HDL (9)				
Hardware Modeling with Verilog HDL – Logic System, Data Types and Operators for Modeling in Verilog HDL - Behavioral Descriptions in Verilog HDL – HDL Based Synthesis – Synthesis of Finite State Machines – Structural modeling – Compilation and Simulation of Verilog code –Test bench - Realization of combinational and sequential circuits using Verilog HDL.				
SYNCHRONOUS SEQUENTIAL CIRCUIT DESIGN (9)				
Analysis of clocked synchronous sequential circuits and modeling - State diagram, state table, state assignment and reduction - Design of synchronous sequential circuits - Design of Iterative circuits - ASM chart and realization using ASM.				
ASYNCHRONOUS SEQUENTIAL CIRCUIT DESIGN (9)				
Analysis of asynchronous sequential circuit – flow table reduction – Races - state assignment- transition table and problems in transition table- Design of asynchronous sequential circuit - Static, dynamic and essential Hazards – Data synchronizers – Mixed operating mode asynchronous circuits.				
FAULT DIAGNOSIS AND TESTABILITY ALGORITHMS (9)				
Fault table method- Path sensitization method – Boolean difference method - D algorithm - Tolerance techniques – The compact algorithm – Fault in PLA – Test generation - DFT schemes – Built in self test.				
SYNCHRONOUS DESIGN USING PROGRAMMABLE DEVICES (9)				
Programming logic device families – Designing a synchronous sequential circuit using PLA/PAL -- Realization of finite state machine using PLD – FPGA – Xilinx FPGA-Xilinx 4000.				

LECTURE: 45 PERIODS TUTORIAL: 0 PERIODS PRACTICAL: 0 PERIODS TOTAL: 45 PERIODS

1

Reference Books:

1. Charles H. Roth Jr "Fundamentals of Logic Design" Thomson Learning 2004, 7th edition 2014.
2. Nripendra N Biswas "Logic Design Theory" Prentice Hall of India, 2010.
3. Parag K. Lala "Fault Tolerant and Fault Testable Hardware Design" B S Publications, 2002.
4. Parag K. Lala "Digital system Design using PLD" B S Publications, 2003.
5. M.D. Ciletti, Modeling, Synthesis and Rapid Prototyping with the Verilog HDL, Prentice Hall, 1999.
6. M.G. Arnold, Verilog Digital – Computer Design, Prentice Hall (PTR), 1999.
7. S. Palnitkar, Verilog HDL – A Guide to Digital Design and Synthesis, Pearson, 2003.

	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11
CO1	2	1	3	2	2	1	2	2	-	-	1
CO2	2	1	1	2	2	-	2	2	-	-	1
CO3	1	1	1	2	3	-	3	1	-	-	1

Controller of Examinations
Government College of Technology
COIMBATORE - 641 013

16VLPC02 DIGITAL CMOS VLSI DESIGN

L	T	P	C
3	0	0	3

CORE/ELECTIVE COURSE: Core

PREREQUISITES:

- Basics of Digital System Design.

COURSE ASSESSMENT METHODS: Both continuous and semester-end assessment.

COURSE OBJECTIVES:

- To learn basic concepts of MOS transistor and inverters.
- To design combinational and sequential logic circuits.
- To gain knowledge in arithmetic building blocks and memory architectures.

COURSE OUTCOMES:

Upon completion of this course, the students will have ability:

- CO1: To understand basic concepts of MOS transistor and CMOS logic.
- CO2: To design CMOS combinational sequential logic circuits.
- CO3: To gain knowledge in arithmetic building blocks and memory architectures.

TOPICS COVERED:

MOS TRANSISTOR PRINCIPLES AND CMOS INVERTER

(9)

MOSFET Transistor Characteristic under Static and Dynamic Conditions, MOS Transistor Secondary Effects, CMOS Inverter. Static Characteristic, Dynamic Characteristic, Power, Energy, and Energy Delay parameters.

COMBINATIONAL LOGIC CIRCUITS

(9)

Static CMOS Design – Complementary CMOS, Ratioed Logic, Pass-Transistor Logic. Dynamic CMOS Design – Dynamic Logic: Basic Principles, Speed and Power Dissipation of Dynamic Logic, Issues in Dynamic Design, Cascading Dynamic Gates.

SEQUENTIAL LOGIC CIRCUITS

(9)

Timing metrics for sequential circuits, Static Latches and Registers, Dynamic Latches and Registers, Pipelines, Pulse and sense amplifier based Registers, Non-Bistable Sequential Circuits.

ARITHMETIC BUILDING BLOCKS AND MEMORY ARCHITECTURES

(9)

Data path circuits, Architectures for Adders, Multipliers, Shifters, Speed and Area Tradeoffs, Array Subsystems: SRAM, DRAM, ROM.

ARCHITECTURE DESCRIPTION

(9)

Introduction, Power distribution, Input/Output, Clock, Hardware Description Languages, Verilog HDL: Behavioral modeling, Structural gate modeling, Switch modeling, Basic constructs, FSM, High-level synthesis.

LECTURE: 45 PERIODS TUTORIAL: 0 PERIODS PRACTICAL: 0 PERIODS TOTAL: 45 PERIODS

Reference Books:

1. Jan M Rabaey, Anantha Chandrakasan, B Nikolic, *Digital Integrated Circuits: A Design Perspective*, Second Edition, 2003, Prentice Hall of India.
2. Niel H.E. Weste, David Harris, Ayan Banerjee, *CMOS VLSI Design- A circuits and Systems Perspective*, Third Edition, 2013, Pearson education.
3. Chris Spear, *System verilog for Verification*, Springer, 2006.
4. Wayne Wolf, *Modern VLSI Design*, PHI Learning Private Limited, New Delhi, 2011.
5. Sung-Mo Kang and Yusuf Leblebici, *CMOS Digital Integrated Circuits*, McGraw Hill, 3rd Edition, 2011.

	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11
CO1	3	3	3	2	2	1	-	-	1	-	-
CO2	3	2	3	2	1	-	1	-	-	-	1
CO3	3	3	2	2	2	1	1	-	1	-	1

Controller of Examinations
Government College of Technology
COIMBATORE - 641 013

16VLPC03 VLSI DESIGN AUTOMATION	L	T	P	C
CORE/ ELECTIVE COURSE: Core				
PREREQUISITES: • Data Structures.				
COURSE ASSESSMENT METHODS: Both continuous and semester-end assessment.				
COURSE OBJECTIVES: • To acquire knowledge on VLSI Design methodologies & CAD tools. • To analyze the design trade off in various partitioning, placement and floor planning in VLSI Design Automation. • To analyze the different global routing Algorithm and acquire knowledge about logical synthesis.				
COURSE OUTCOMES: Upon completion of this course, the students will have: CO1: Knowledge on VLSI Design methodologies & CAD tools. CO2: An ability to analyze the design trade off in various partitioning, placement and floor planning in VLSI Design Automation. CO3: An ability to analyze the different global routing Algorithm and acquire knowledge about logical synthesis.				
TOPICS COVERED VLSI DESIGN METHODOLOGIES (9) Introduction to VLSI Design Methodologies: VLSI Design Cycle - New trends in VLSI design Cycle- Physical Design – New trends in physical design cycle – Design styles - VLSI Design Automation Tools - Algorithmic graph theory and computational complexity - Tractable and intractable problems. PARTITIONING & PLACEMENT (9) Partitioning – Problem formulation – Group migration Algorithms – KL,FM Algorithms, Placement – Simulation based algorithm – Simulated annealing, Force directed algorithm, Partition based algorithms – Breuer’s Algorithm, Terminal propagation Algorithm, Floor planning – Slicing floor plan, Constrained Based Floor planning – Pin assignment. ROUTING (9) Routing - Grid routing – Maze routing Algorithms, Global routing – Shortest path based Algorithm, Steiner free based Algorithm, Detailed routing – Left edge Algorithm, Greedy channel Routing – Over the cell routing, clock routing. SIMULATION (9) Simulation – Gate level modeling and Simulation – Switch level modeling and simulation -- Switch level modeling and simulation - Combinational Logic Synthesis – Binary decision diagrams – Two level logic Synthesis.				

MODELING AND SYNTHESIS**(9)**

High level synthesis – Hardware models – Internal representation – Allocation assignment and scheduling – High level transformation.

LECTURE: 45 PERIODS TUTORIAL: 0 PERIODS PRACTICAL: 0 PERIODS TOTAL: 45 PERIODS

Reference Books:

I.N.A Sherwani, " Algorithms for VLSI Physical Design Automation ", Kluwer Academic Publishers, 2007.

2.S.H. Gerez, " Algorithms for VLSI Design Automation ", John Wiley & Sons, 2008.

	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11
CO1	2	3	2	2	3	2	1	2	3	3	-
CO2	2	3	2	2	3	2	1	2	3	3	-
CO3	2	3	2	2	3	3	1	3	3	3	-

Controller of Examinations
Government College of Technology
COIMBATORE - 641 013

16VLPC04 VLSI DESIGN LABORATORY

L	T	P	C
0	0	4	2

CORE/ ELECTIVE COURSE: Core**PREREQUISITES:**

- VLSI

COURSE ASSESSMENT METHODS: Both continuous and semester-end assessment.**COURSE OBJECTIVES:**

- To acquire Knowledge on modelling and synthesis of digital system design using HDL programming languages.
- To Implement the design using FPGA/CPLD devices.
- To get exposure to critical path time calculations and RTL modules.

COURSE OUTCOMES:**Upon completion of the course, the students will have:**

CO1: Knowledge on modelling and synthesis of digital system design using HDL programming languages.

CO2: Ability to design using FPGA/CPLD devices.

CO3: An exposure to critical path time calculations and RTL modules.

TOPICS COVERED**VLSI Front End Design programs**

Programming can be done using any HDL compiler, Verification of the Functionality of the module using functional Simulator, Timing Simulation for Critical Path time Calculation, Synthesis of module, Place & Route and implementation of design using FPGA/CPLD Devices.

1. Design and Simulation of Half and Full adders, Serial Binary Adder, Multi Precision Adder, Carry Look Ahead Adder.
2. Design of 4-bit binary, BCD counters (synchronous/ asynchronous reset).
3. Design of a N- bit shift register of Serial- in Serial – out, Serial in parallel out, Parallel in Serial out and Parallel in Parallel Out.
4. Design of Sequence Detector (Finite State Machine- Mealy and Moore Machines).
5. Design of 4- Bit Multiplier and 4-bit Divider.
6. Design of ALU to Perform – ADD, SUB, AND, OR, 1's compliment, 2's Compliment, Multiplication and Division.
7. Design of Finite State Machine.
8. System Implementation (LCD Interfacing / Keypad Interfacing)
9. Design of Memories

LECTURE: 0 PERIODS TUTORIAL: 0 PERIODS PRACTICAL: 60 PERIODS TOTAL: 60 PERIODS

Reference Books:

1. Charles Roth Jr.H., "Fundamentals of Logic Design", Australia cengage learning,2014,7th edition.
2. Samir Palnitkar, "Verilog HDL-A guide to Digital Design and synthesis second edition Pearson", Education in South Asia 2013.
3. "The design warrior guide to FPGA's, devices, Tools and flows". Clive Maxfield,2011.
4. Altera Corporation-"Standard Cell ASIC to FPGA Design Methodology and Guidelines", April 2009.

	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11
CO1	3	3	-	3	2	-	3	-	-	-	-
CO2	3	3	2	3	2	-	3	-	-	-	-
CO3	3	3	-	2	2	-	3	-	-	-	-

Controller of Examinations
Government College of Technology
COIMBATORE - 641 013

16VLPC05 ANALOG VLSI				L	T	P	C
CORE/ELECTIVE COURSE: Core							
PREREQUISITES:							
<ul style="list-style-type: none"> Digital CMOS VLSI design. 							
COURSE ASSESSMENT METHODS: Both continuous and semester-end assessment.							
COURSE OBJECTIVES:							
<ul style="list-style-type: none"> To understand analog transistor fundamentals, circuits and amplifiers of CMOS FET. To gain knowledge analog filters and converters. To test the analog circuits and to apply their knowledge to build common analog blocks. 							
COURSE OUTCOMES:							
<p>Upon completion of this course, the students will be able to:</p> <p>CO1: Understand analog transistor fundamentals, circuits and amplifiers of CMOS FET.</p> <p>CO2: Gain knowledge analog filters and converters.</p> <p>CO3: Test the analog circuits and to apply their knowledge to build common analog blocks.</p>							
TOPICS COVERED							
BASIC MOS DEVICE PHYSICS				(9)			
MOS Device Models- Review of Small Signal MOS Transistor Models-basic CMOS circuits-basic gain stage –super MOS transistor –Primitive analog cells - BICMOS Technology- fabrication, layout, design rules-Passive IC components: capacitor, resistor, inductor, transformer.							
BASIC ANALOG CIRCUITS AND AMPLIFIERS:				(9)			
Current sources and sinks - Current mirrors/amplifiers - Voltage and current references, Comparator, Multiplier. AMPLIFIERS- MOS and BJT inverting amplifier - Improving performance of inverting amplifier - CMOS and BJT differential amplifiers - Characterization of Op-Amp - The BJT two stage op-amp - The CMOS two stage op-amp -Op-amps with output stage, Folded cascode op-amp, Transconductance Amplifier- Instrumentation amplifier.							
NOISE AND FILTERS:				(9)			
Noise Spectrum, Sources, Types, Thermal and Flicker noise, Representation in circuits, Noise Bandwidth, Noise Figure. Low pass filters - High pass filters – Band Pass filters – Switched capacitor filters - Phase Locked Loops.							
D/A AND A/D CONVERTERS:				(9)			
Ideal A/D and D/A converters, Quantization noise, Signed codes, Performance limitations. D/A converter: Current scaling, Voltage scaling and Charge scaling D/A converters - Serial D/A converters - Serial A/D converters, Parallel - High performance A/D converters.							
ANALOG VLSI TESTING AND SYSTEMS:				(9)			
FAULT modelling and simulation - BIST -- Analog VLSI for Vision - System Design Issues - An Integrated Image Acquisition, Smoothing and Segmentation Focal Plane Processor.							

LECTURE: 45 PERIODS TUTORIAL: 0 PERIODS PRACTICAL: 0 PERIODS TOTAL: 45 PERIODS

Reference Books:

1. Behzad Razavi, *Design of Analog CMOS Integrated Circuits*, McGraw Hill, 2nd Edition 2002.
2. Gray, P.R., Hurst, P.J., Lewis, S.H., and Meyer, R.G., *Analysis and Design of Analog Integrated Circuits*, John Wiley, 5th Edition, 2001.
3. Mohammed Ismail, *Analog VLSI signal and Information processing*, McGraw-Hill, 1994.
4. John L. Wyatt et.al, *Analog VLSI Systems for Image Acquisition and Fast Early Vision Processing*, International Journal of Computer Vision.

	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11
CO1	3	2	3	2	3	2	1	-	-	2	-
CO2	3	3	2	3	2	1	2	-	-	1	-
CO3	3	3	3	2	1	1	1	-	-	2	-

Controller of Examinations
Government College of Technology
COIMBATORE - 641 013

16VLPC06 LOW POWER VLSI DESIGN

L	T	P	C
3	0	0	3

CORE/ ELECTIVE COURSE: Core**PREREQUISITES:**

- Digital CMOS VLSI design.

COURSE ASSESSMENT METHODS: Both continuous and semester-end assessment.**COURSE OBJECTIVES:**

- To be aware of power consumption , power dissipation in CMOS device and get exposed to logic level power optimization.
- To gain Knowledge on low power design and power estimation techniques in CMOS circuits.
- To Understand the synthesis and software design for low power .

COURSE OUTCOMES:**Upon completion of the course, the students will have:**

- CO1: Awareness of power consumption , power dissipation in CMOS device and get exposed to logic level power optimization.
- CO2: Knowledge on low power design and power estimation techniques in CMOS circuits.
- CO3: Understanding of the synthesis and software design for low power.

TOPICS COVERED:**POWER DISSIPATION IN CMOS****(9)**

Hierarchy of limits of power – Sources of power consumption – Physics of power dissipation in CMOS FET-devices- Basic principle of low power design.

POWER OPTIMIZATION**(9)**

Logical level power optimization – Circuit level low power design – Circuit techniques for reducing power consumption in adders and multipliers.

DESIGN OF LOW POWER CMOS CIRCUITS**(9)**

Computer Arithmetic techniques for low power systems – Reducing power consumption in memories – Low power clock, Interconnect and layout design – Advanced techniques – Special techniques.

POWER ESTIMATION**(9)**

Power estimation techniques – Logic level power estimation – Simulation power analysis – Probabilistic power analysis.

SYNTHESIS AND SOFTWARE DESIGN FOR LOW POWER**(9)**

Synthesis for low power –Behavioral level transforms- Software design for low power.

LECTURE: 45 PERIODS TUTORIAL: 0 PERIODS PRACTICAL: 0 PERIODS TOTAL: 45 PERIODS

Reference Books:

1. K.Roy and S.C. Prasad , " *Low Power CMOS VLSI*" circuit design, Wiley, 2009.
2. Dimitrios Soudris, Chirstian Pignet, Costas Goutis, " *Designing CMOS circuits for low power*", Springer US 2010.

3. B. Kuo and J.H Lou, "Low voltage CMOS VLSI Circuits", Wiley 2014.
4. Gary K.Yeap, "Practical Low Power Digital VLSI Design", Springer Science and business media,2012.
5. James B. Kuo, Shin – chia Lin, Low voltage "SOI CMOS VLSI" Devices and Circuits. John Wiley and sons, inc2004.

	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11
CO1	3	2	2	2	2	-	-	-	2	-	-
CO2	3	2	-	2	2	-	-	-	2	-	-
CO3	2	2	2	-	3	-	2	1	2	-	-

Contreller of Examinations
Government College of Technology
COIMBATORE - 641 013

16VLPC07 VLSI SIGNAL PROCESSING	L 3	T 0	P 0	C 3
CORE/ ELECTIVE COURSE: Core				
PREREQUISITES: <ul style="list-style-type: none"> • Digital signal processing. • VLSI Architecture. 				
COURSE ASSESSMENT METHODS: Both continuous and semester-end assessment.				
COURSE OBJECTIVE: <ul style="list-style-type: none"> • To improve the performance of the existing FIR filter structures to suit VLSI designs. • To design efficient IIR filter structures and Bit level architectures suitable for VLSI Designs. • To modify the clocking styles, synchronous and Asynchronous protocols suitable for VLSI Architectures. 				
COURSE OUTCOMES: Upon completion of this course the students will have: CO1 : Ability to improve the performance of the existing FIR filter structures to suit VLSI designs. CO2 : Ability to design efficient IIR filter structures and Bit level architectures suitable for VLSI designs. CO3 : Ability to modify the clocking styles, synchronous and Asynchronous protocols suitable for VLSI Architectures.				
TOPICS COVERED: INTRODUCTION TO DSP SYSTEMS, PIPELINING AND PARALLEL PROCESSING OF FIR FILTERS (9) Introduction to DSP systems – Typical DSP algorithms, Data flow and Dependence graphs - critical path, Loop bound, iteration bound, Longest path matrix algorithm, Pipelining and Parallel processing of FIR filters, Pipelining and Parallel processing for low power. RETIMING, ALGORITHMIC STRENGTH REDUCTION (9) Retiming – definitions and properties, Unfolding – an algorithm for unfolding, properties of unfolding, sample period reduction and parallel processing application, Algorithmic strength reduction in filters and transforms – 2-parallel FIR filter, 2-parallel fast FIR filter, DCT architecture, rank-order filters, Odd-Even merge-sort architecture, parallel rank-order filters. FAST CONVOLUTION, PIPELINING AND PARALLEL PROCESSING OF IIR FILTERS (9) Fast convolution – Cook-Toom algorithm, modified Cook-Toom algorithm, Pipelined and parallel recursive filters – Look-Ahead pipelining in first-order IIR filters, Look-Ahead pipelining with power-of-2 decomposition, Clustered look-ahead pipelining, Parallel processing of IIR filters, combined pipelining and parallel processing of IIR filters.				

BIT-LEVEL ARITHMETIC ARCHITECTURES**(9)**

Bit-level arithmetic architectures – parallel multipliers with sign extension, parallel carry-ripple and carry-save multipliers, Design of Lyon’s bit-serial multipliers using Horner’s rule, bit-serial FIR filter, CSD representation, CSD multiplication using Horner’s rule for precision improvement, Distributed Arithmetic fundamentals and FIR filters.

NUMERICAL STRENGTH REDUCTION, SYNCHRONOUS, WAVE AND ASYNCHRONOUS PIPELINING**(9)**

Numerical strength reduction – subexpression elimination, multiple constant multiplication, iterative matching, synchronous pipelining and clocking styles, clock skew in edge-triggered single phase clocking, two-phase clocking, wave pipelining, Asynchronous pipelining, bundled data versus dual rail protocol.

LECTURE: 45 PERIODS TUTORIAL: 0 PERIODS PRACTICAL: 0 PERIODS TOTAL: 45 PERIODS

Reference Books:

1. Keshab K. Parhi, “ *VLSI Digital Signal Processing Systems, Design and implementation* “, Wiley, Interscience, 2007.
2. U. Meyer – Baese, “ *Digital Signal Processing with Field Programmable Gate Arrays*”, Springer, Second Edition, 2004.
3. Kung S. Y, H. J. While House, T. Kailath, “*VLSI and Modern Signal Processing*”, Prentice Hall, 1985.
4. Jose E. France, Yannis Tsvividis “*Design of Analog – Digital VLSI Circuits for Telecommunications and Signal Processing*”, Prentice Hall, 1994.
5. Medisetti V. K, “*VLSI Digital Signal Processing*”, IEEE Press (NY), USA, 1995..

	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11
CO1	2	-	1	-	1	1	-	1	1	-	-
CO2	2	-	1	-	1	1	1	-	-	-	1
CO3	2	-	1	-	1	1	-	1	-	-	1

Controller of Examinations
Government College of Technology
COIMBATORE - 641 013

16VLPC08 ASIC DESIGN	L	T	P	C
	3	0	0	3
CORE/ ELECTIVE COURSE: Elective				
PREREQUISITES:				
<ul style="list-style-type: none"> • VLSI Technology. 				
COURSE ASSESSMENT METHODS: Both continuous and semester-end assessment.				
COURSE OBJECTIVES				
<ul style="list-style-type: none"> • To Gain the fundamentals of ASIC design. • To Gain Knowledge on programmable ASIC s. • To Gain Knowledge in the logical synthesis , simulation and testing aspects of ASIC 				
COURSE OUTCOMES:				
After completing this course, the students will have:				
CO1: Sufficient theoretical knowledge for carrying out the ASIC design.				
CO2: Knowledge about programmable ASIC s.				
CO3: Knowledge in the logical synthesis , simulation and testing aspects of ASIC .				
TOPICS COVERED:				
OVERVIEW OF ASIC AND PLD (9)				
Types of ASICs - Design flow – CAD tools used in ASIC Design – Programming Technologies: Antifuse – static RAM – EPROM and EEPROM technology, Programmable Logic Devices : ROMs and EPROMs – PLA –PAL. Gate Arrays – CPLDs and FPGA.				
PROGRAMMABLE ASIC s (9)				
Programmable ASIC cells for ACTEL and XILNX -DC & AC inputs and outputs-ACTEL and XILINX–programmable ASIC architecture-Clock and Power inputs – Architecture and I/O blocks -XILINX XC 4000- FLEX 8000/10000, ACTEL’s ACT-1,2,3 and their speed performance, Altera MAX 5000 and 7000 - Altera MAX 9000 – Spartan II and Virtex II FPGAs - Apex and Cyclone FPGAs.				
ASIC PHYSICAL DESIGN (9)				
System partition Partitioning - Partitioning methods – Interconnect delay models and measurement of delay - Floor planning - Placement – Routing : Global routing - Detailed routing - Special routing.				
LOGIC SYNTHESIS, SIMULATION AND TESTING (9)				
Design systems Logic Synthesis - Verilog and VHDL synthesis - Types of simulation -Boundary scan test - Fault simulation - Automatic test pattern generation.				
HIGH PERFORMANCE ALGORITHMS FOR ASICS/ SOCS. (9)				
DAA and computation of FFT and DCT. High performance filters using delta-sigma modulators. Case Studies: Digital camera, SDRAM, High speed data standards.				

LECTURE: 45 PERIODS TUTORIAL: 0 PERIODS PRACTICAL: 0 PERIODS TOTAL: 45 PERIODS

Reference Books:

1. M.J.S.Smith, "Application - Specific Integrated Circuits", Pearson, 200
2. Steve Kilts, "Advanced FPGA Design," Wiley Inter-Science.
3. Roger Woods, John McAllister, Dr. Ying Yi, Gaye Lightbod, "FPGA-based Implementation of Signal Processing Systems", Wiley, 2008.
4. Mohammed Ismail and Terri Fiez, "Analog VLSI Signal and Information Processing ", Mc Graw Hill, 1994.
5. Douglas J. Smith, **HDL Chip Design**, Madison, AL, USA: Doone Publications, 1996.
6. Jose E. France, Yannis Tsvividis, "Design of Analog - Digital VLSI Circuits for Telecommunication and Signal Processing", Prentice Hall, 1994.

	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11
CO1	1	-	-	-	-	-	2	2	2	2	3
CO2	3	2	2	1	1	-	-	2	2	2	3
CO3	1	3	-	-	-	-	2	2	2	2	3

Controller of Examinations
Government College of Technology
COMBATORE - 641 013

16VLPC09 SYSTEM LEVEL DESIGN LABORATORY	L	T	P	C
	0	0	4	2
CORE/ELECTIVE COURSE: core				
PREREQUISITES:				
<ul style="list-style-type: none"> • Analog IC Design. • Digital CMOS VLSI Design. • Advanced Digital System Design. 				
COURSE ASSESSMENT METHODS: Both continuous and semester-end assessment.				
COURSE OBJECTIVES:				
<ul style="list-style-type: none"> • To analyze analog, digital and mixed signal circuits. • To gain knowledge on different facets of VLSI design using CAD tools. • Hands on experience on VLSI based experiments using simulation and synthesis tools. 				
COURSE OUTCOMES:				
At the end of the course the student will be able to/ have an:				
CO1:Analyze analog, digital and mixed signal circuits.				
CO2:Gain knowledge on different facets of VLSI design using CAD tools.				
CO3:Hands on experience on VLSI based experiments using simulation and synthesis tools.				
TOPICS COVERED:				
Analog Circuits:				
1. AN INVERTER				
2. MOS DIFFERENTIAL AMPLIFIER				
3. COMMON SOURCE AMPLIFIER & COMMON DRAIN AMPLIFIER				
4. OPERATIONAL AMPLIFIER				
Mixed Signal Circuits:				
5. R-2R DAC				
6. SAR BASED ADC				
7. PLL				
Digital Signal/Circuits:				
8. GCD-computer (4-bit)				
9. Booth multiplier (4-bit)				
10. 4-pt FFT/IFFT				
Hardware Co-Simulation using FPGA kits:				
11. CORDIC for $\sin \theta / \cos \theta$ & $\sin^{-1} \theta / \cos^{-1} \theta$				
12. Adders & Multipliers				
13. Edge Detection				
Tools: CADENCE / TANNER /Mentor/Synopsis/HDL Simulation and Synthesis tools.				
LECTURE: 0 PERIODS TUTORIAL: 0 PERIODS PRACTICAL: 60 PERIODS TOTAL: 60 PERIODS				

References Books

1. Behzad Razavi, *Design of Analog CMOS Integrated Circuits*, McGraw Hill, 2nd Edition 2002.
2. Gray, P.R., Hurst, P.J., Lewis, S.H., and Meyer, R.G., *Analysis and Design of Analog Integrated Circuits*, John Wiley, 5th Edition, 2001.
3. Samir Palnitkar, *Verilog HDL-A Guide to digital design and synthesis*, 2nd Edition, Pearson Education, 2013.
4. *System Generator for DSP User Guide*, 2012.

	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11
CO1	3	2	2	2	2	-	1	-	-	-	1
CO2	2	3	2	1	3	-	-	-	-	-	-
CO3	2	1	2	3	3	-	-	1	-	-	-

Controller of Examinations
Government College of Technology
COIMBATORE - 641 013

16VLPE01 IMAGE AND VIDEO PROCESSING (Common to Applied Electronics)	L 3	T 0	P 0	C 3
CORE/ ELECTIVE COURSE: Elective				
PREREQUISITES: <ul style="list-style-type: none"> Digital Signal Processing. 				
COURSE ASSESSMENT METHODS: Both continuous and semester-end assessment.				
COURSE OBJECTIVES: <ul style="list-style-type: none"> To gain knowledge on the basics of digital imaging. To get exposure to various image processing techniques. To get exposure to video processing. 				
COURSE OUTCOMES: Upon completion of this course, the students will have: CO1: Knowledge on the basics of digital imaging. CO2: Exposure to various image processing techniques. CO3: Exposure to video processing.				
TOPICS COVERED:				
DIGITAL IMAGE PROCESSING FUNDAMENTALS				(9)
Image Processing Systems- Elements of visual perception- Image sensing and acquisition- Image sampling and quantization. Pixel relationships- Statistical properties- Histogram, mean, Standard deviation-. Color Image Fundamentals, Chromaticity diagram. Color models- Image file formats, Image transforms, Discrete fourier transform- Discrete cosine transform- wavelet transform.				
IMAGE ENHANCEMENT AND RESTORATION				(9)
Enhancement in spatial domain- Basic gray level transforms- Histogram processing- Spatial Filtering- Enhancement in frequency domain- Image restoration- Degradation model- Noise models- Spatial Filters- Frequency domain filters.				
IMAGE SEGMENTATION AND REPRESENTATION				(9)
Detection of discontinuities- Point, Line and Edge detection- Gradient operators- Thresholding- Region based segmentation- Representation schemes- Chain codes- Polygon approximation- Boundary descriptors- Simple descriptors- Shape number- Fourier descriptors.				
VIDEO FUNDAMENTALS				(9)
Basic concepts and Terminology-Monochrome Analog video – Color in Video – Analog video standards – Digital video basics – Analog-to Digital conversion – Color representation and chroma sub sampling – Digital video formats and standards Video sampling rate and standards conversion.				
Controller of Examinations Government College of Technology COIMBATORE - 641 013				

VIDEO OBJECT EXTRACTION**(9)**

Back ground subtraction – Frame difference – Static and dynamic background modeling – Optical flow techniques – Handling occlusion – Scale and appearance changes – Shadow removal.

LECTURE: 45 PERIODS TUTORIAL: 0 PERIODS PRACTICAL: 0 PERIODS TOTAL: 45 PERIODS

Reference Books :

1. Rafael C. Gonzalez, Richard E. Woods, “*Digital Image Processing*”, Pearson Education, Inc., Second Edition, 2004.
2. Anil K. Jain, “*Fundamentals of Digital Image Processing*”, Prentice Hall of India, 2002.
3. Oges Marques, “*Practical Image and Video Processing Using MATLAB*”, Wiley-IEEE Press, 2011.
4. A.Bovik, “*Handbook of Image and Video processing*”, 2nd Edition, Academic press, 2005.
5. Mark Nixon and Alberto Aguado, “*Feature Extraction and Image Processing*”, Academic Press, 2008.
6. Rafael C. Gonzalez, Richard E. Woods, Steven Eddins, “*Digital Image Processing using MATLAB*”, Pearson Education, Inc., 2004.
7. Jayaraman S, Esakkirajan S and Veerakumar J, “*Digital Image Processing*”, Tata McGraw Hill Education pvt ltd, 2010.

	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11
CO1	2	3	2	2	3	2	1	1	1	3	-
CO2	3	3	2	2	3	3	1	1	3	3	-
CO3	3	3	2	2	3	3	1	1	3	3	-

Controller of Examinations
Government College of Technology
COIMBATORE - 641 013

16VLPE02 MIXED SIGNAL CIRCUITS AND INTERFACING (Common to Applied Electronics)	L 3	T 0	P 0	C 3
CORE/ ELECTIVE COURSE: Core				
PREREQUISITES: • A-D & D-A Converters.				
COURSE ASSESSMENT METHODS: Both continuous and semester-end assessment.				
COURSE OBJECTIVES: • To gain basic knowledge on Sample and Hold Architecture. • To acquire knowledge on various A-D & D-A converters Architecture. • To gain Knowledge on Building Blocks & Precision Techniques.				
COURSE OUTCOMES: Upon completion of this course the students will have: CO 1: Basic knowledge on Sample and Hold Architecture. CO 2: Knowledge on various A-D & D-A converters Architecture. CO 3: Knowledge on Building Blocks & Precision Techniques.				
TOPICS COVERED: SAMPLE-AND-HOLD ARCHITECTURES (9) Introduction to Data conversion and Processing- Sampling Switches-MOS, Diode Switches-Improvements in MOS Switch Performance-Conventional Open-Loop and Closed-Loop Architecture, Open-Loop Architecture with Miller Capacitance, Multiplexed-Input Architectures, Recycling Architecture, Switched-Capacitor Architecture, Current-Mode Architecture. DIGITAL-TO-ANALOG CONVERTER ARCHITECTURES (9) Basic principles-General Considerations-Performance Metrics-Reference Multiplication and Division-Switching and Logical Functions in DACs-Resistor-Ladder DAC Architectures, Current-Steering Architectures. ANALOG-TO-DIGITAL CONVERTER ARCHITECTURES (9) General Considerations- Performance Metrics- Flash Architectures, Two-Step Architectures, Interpolative and Folding Architectures, Pipelined Architectures, Successive Approximation Architectures, Interleaved Architectures. BUILDING BLOCKS OF DATA CONVERSION SYSTEMS (9) Amplifiers- Open-Loop Amplifiers, Closed-Loop Amplifiers, Operational Amplifiers, Gain Boosting Techniques, Common-Mode Feedback. Comparators- Bipolar Comparators, CMOS Comparators,				

BiCMOS Comparators.

PRECISION TECHNIQUES

(9)

Comparator Offset Cancellation- Input, Output and multistage Offset Storage, Comparators Using Offset-Cancelled Latches- Op Amp Offset Cancellation- Calibration Techniques- DAC and ADC Calibration Techniques.

LECTURE: 45 PERIODS TUTORIAL: 0 PERIODS PRACTICAL: 0 PERIODS TOTAL: 45 PERIODS

Reference Books:

1. BehzadRazavi, "*Principles of Data Conversion System Design*", JohnWiley & Sons, 2011.
2. Sundaram Natarajan, "*Microelectronics Analysis & design*", McGrawHill 2006.
3. R.JBaker, "*CMOS Mixed Signa lCircuit Design*", Wiley Interscience, 2nd Edition, 2009.
4. B.Razavi, "*Design of Analog CMOS Integrated Circuits*", McGrawHill, 2005.
5. David A. Johns and Ken Martin, "*Analog Integrated Circuit Design*", WileyIndia, 2008.

	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11
CO1	3	1	2	2	2	-	2	1	1	2	2
CO2	3	-	2	-	-	-	-	-	-	-	-
CO3	3	3	1	-	2	-	1	-	1	-	-

Controllor of Examinations
Government College of Technology
COIMBATORE - 641 013

16VLPE03 RF SYSTEM DESIGN (Common to Applied Electronics)	L 3	T 0	P 0	C 3
CORE/ ELECTIVE COURSE: Elective				
PREREQUISITES:				
<ul style="list-style-type: none"> • Transmission Lines,RF System. 				
COURSE ASSESSMENT METHODS: Both continuous and semester-end assessment.				
COURSE OBJECTIVES:				
<ul style="list-style-type: none"> • To gain knowledge on issues in designing RFIC and concepts of transistors. • To gain knowledge on integrated circuits design using Passive components. • To gain knowledge on RF Amplifiers and RF Mixers designs. 				
COURSE OUTCOMES:				
Upon completion of this course, the students will have:				
CO1 : Detailed Knowledge on issues in designing RFIC and concepts of transistors.				
CO2 : Ability to design integrated circuits using Passive components.				
CO3 : Detailed Knowledge on RF Amplifiers and RF Mixers designs.				
TOPICS COVERED:				
ISSUES IN RFIC DESIGN, NOISE, LINEARITY, AND FILTERING: (9)				
Lower frequency analog design and microwave design versus radio frequency integrated circuit design - Impedance levels for microwave and low-frequency analog design- noise - linearity and distortion in RF Circuits - dynamic range - filtering issue.				
REVIEW OF TECHNOLOGY : (9)				
Small -signal model of bipolar transistor - high frequency effects - noise in bipolar transistors - base shot noise-noise sources in the transistor model - bipolar transistor design considerations-CMOS transistor.- impedance matching - tapped capacitors and inductors - the concept of mutual inductance - tuning a transformer - bandwidth of an impedance transformation network-quality factor of an LC resonator.				
DESIGN OF PASSIVE CIRCUIT ELEMENTS IN IC TECHNOLOGIES: (9)				
Technology backend and metallization in IC technologies - sheet resistance and skin effect -parasitic capacitance and inductance -current handling in metal lines-design of inductors and transformers - characterization of inductor-layout of spiral inductors - on-chip transmission lines - high frequency measurements of on-chip passives and common De-Embedding techniques-packaging.				
LNA AND POWER AMPLIFIER: (9)				
Basic amplifiers - amplifiers with feedback - noise in amplifiers - linearity in amplifiers - differential pair and other differential amplifiers-low-voltage topologies for LNAs and the use of on-chip transformers - DC bias networks - temperature effects - broad band LNA design. Power amplifier: power capability - efficiency calculations - matching considerations - Class A,B,C,D,E,F,G,H and S amplifiers -summary of amplifier classes for RF Integrated circuits - AC load line - matching to achieve desired power -				

packaging -effects and implications of non linearity - linearization techniques - CMOS power amplifier example.

MIXERS: (9)

Mixing with nonlinearity - basic mixer operation - controlled transconductance mixer - double-balanced mixer - mixer with switching of upper quad - analysis of switching modulator-mixer noise - linearity - improving isolation - image reject and single -sideband mixers-alternative mixer designs - general design comments-CMOS mixers.

LECTURE: 45 PERIODS TUTORIAL: 0 PERIODS PRACTICAL: 0 PERIODS TOTAL: 45 PERIODS

Reference Books:

1. John Rogers and Calvin Plett, "Radio Frequency Integrated Circuit Design", Artech House, 2002.
2. Stephan A Mass, "Non-Linear Microwave and RF circuits", Artech House.
3. Ferri Losee, "RF Systems, Components and Circuits handbook", Artech house, 2002.
4. Larson LE, "RF and Microwave Circuit for Wireless Applications", Artech House, 1997.

	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11
CO1	3	-	-	-	1	1	1	1	-	-	1
CO2	2	3	-	-	1	-	-	1	-	-	1
CO3	1	-	1	1	1	1	-	1	1	-	-

Controller of Examinations
Government College of Technology
COIMBATORE - 641 013

16VLPE04 MICROSENSORS AND MEMS (Common to Applied Electronics)	L	T	P	C
	3	0	0	3
CORE/ ELECTIVE COURSE: Elective				
PREREQUISITES:				
<ul style="list-style-type: none"> Basic science, Basic engineering. 				
COURSE ASSESSMENT METHODS: Both continuous and semester-end assessment.				
COURSE OBJECTIVES:				
<ul style="list-style-type: none"> To understand the microfabrication process, MEMS materials and various system issues. To acquire basic knowledge on electrical and mechanical concepts of MEMS. To acquire knowledge on various types of microsensors. To introduce the concepts of optical and RF MEMS and various case studies. 				
COURSE OUTCOMES:				
Upon completion of this course, the students will have:				
CO 1: Knowledge on microfabrication process, MEMS materials and various system issues.				
CO 2: Basic knowledge on electrical and mechanical concepts of MEMS.				
CO 3: Knowledge on various types of microsensors.				
CO 4: Introduction to optical and RF MEMS and various case studies.				
TOPICS COVERED:				
MICROFABRICATION AND MATERIALS (9)				
Introduction – Evolution of MEMS – Microsensors and actuators – Microfabrication – Lithography, Etching, Deposition, Oxidation, Diffusion - MEMS materials – Metals – Physical and chemical properties, Metallization – Semiconductors – Electrical and chemical properties, Growth and Deposition – Bulk and Surface micromachining.				
ELECTRICAL AND MECHANICAL CONCEPTS (9)				
Conductivity and resistivity – Elasticity – Stress and strain – Isotropic and Anisotropic materials – Bending of beams – types, Deflection – Pure bending – Torsional deflections – intrinsic stress – Resonance – Viscosity - Surface tension.				
MEMS ISSUES AND CASE STUDIES (9)				
Circuit and System issues – Electronics, Feedback systems and Noises. Case studies – Commercial pressure sensor, MEMS magnetic actuators, Capacitive accelerometer.				
TYPES OF MICROSENSORS (9)				
Introduction – Thermal sensors, Radiation sensors, Mechanical sensors – Pressure microsensors and Flow microsensors, Magnetic sensors, Bio(Chemical) sensors – SAW-IDT microsensor – fabrication – applications – Strain, Temperature, Pressure and Humidity sensor.				
OPTICAL AND RF MEMS (9)				
Optical MEMS – Passive MEMS optical components – Lenses, Mirrors – Active actuators for optical MEMS – Translation and rotation motion – RF MEMS – Basics - Sample case studies of optical and RF MEMS.				

LECTURE: 45 PERIODS TUTORIAL: 0 PERIODS PRACTICAL: 0 PERIODS TOTAL: 45 PERIODS

Reference Books:

1. Stephen Santuria, "Microsystems Design", Kluwer publishers, 2000.
2. Julian w. Gardner, Vijay K. Varadan, Osama O. Awadelkarim, "Micro Sensors MEMS and Smart Devices", John Wiley & Son LTD, 2002.
3. Chang Liu, "Foundations of MEMS", Pearson Education Inc., 2006.
4. Nadim Maluf, "An introduction to Micro electro mechanical system design", Artech House, 2000.
5. Mohamed Gad-el-Hak, editor, "The MEMS Handbook", CRC press Baco Raton, 2000.
6. Tai Ran Hsu, "MEMS & Micro systems Design and Manufacture" Tata McGraw Hill, New Delhi, 2002.
7. James J.Allen, "Micro Electro Mechanical System Design", CRC Press Publisher, 2010.

	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11
CO1	3	-	-	-	-	-	-	-	-	-	-
CO2	2	-	-	-	-	-	-	-	-	-	-
CO3	3	-	-	-	-	-	-	-	-	-	-
CO4	1	-	-	-	-	-	-	-	2	-	-

Controller of Examinations
Government College of Technology
COIMBATORE - 641 013

16VLPE05 GRAPH THEORY AND OPTIMIZATION TECHNIQUES (Common to Applied Electronics)	L	T	P	C
	3	0	0	3
CORE/ELECTIVE COURSE: Elective				
PREREQUISITES:				
<ul style="list-style-type: none"> • NIL 				
COURSE ASSESSMENT METHODS: Both continuous and semester-end assessment.				
COURSE OBJECTIVES:				
<ul style="list-style-type: none"> • To solve problems in graphs and trees. • To implement the appropriate graph theoretic algorithms for the given problem. • To solve the optimization problem using linear and non-linear programming. 				
COURSE OUTCOMES:				
Upon completion of this course the students will have:				
CO 1: An ability to solve problems in graphs and trees.				
CO 2: An ability to apply graph theoretic algorithms for the given problem.				
CO 3: An ability to solve the optimization problem using linear and non-linear programming.				
TOPICS COVERED:				
GRAPHS AND TREES (9)				
Basic definitions and examples of graph - Subgraphs – Isomorphism - Operations on Graphs – Hamiltonian path and Euler graph - Connectivity – Matrix representation of graphs – Directed graphs Trees – properties of trees – Spanning tree.				
GRAPH COLORING (9)				
Planar graphs – Different representation, Graph duality – Geometric dual and Combinatorial dual - Graph coloring – Chromatic number - Chromatic partitioning – Coverings – Matchings - Four color problem – Regularization of a planar graph.				
GRAPH THEORETIC ALGORITHMS (9)				
Computer representation of a graph - Some basic algorithms for graph – Shortest path algorithms for specified vertex to another vertex and all pairs of vertices – Minimal spanning tree algorithm – Kruskal and Prim’s algorithm – Depth first and breadth first search algorithms..				
CLASSICAL OPTIMIZATION AND LINEAR PROGRAMMING (9)				
Single variable optimization – Multivariable optimization with various constraints – Lagrange’s method, Kuhn-Tucker condition – Linear Programming – Simplex method – Unbounded and infinite number of solutions – Duality in linear programming – Transportation problem				
NON-LINEAR PROGRAMMING (9)				
Elimination methods – Unrestricted search, Fibonacci method, Golden section method – Unconstrained minimization – Direct search methods - Random search methods and Grid search methods, Indirect search methods – Steepest descent method and conjugate gradient method.				
LECTURE: 45 PERIODS TUTORIAL: 0 PERIODS PRACTICAL: 0 PERIODS TOTAL: 45 PERIODS				

ReferenceBooks:

1. Narsingh Deo, "Graph Theory with Applications to Engineering and Computer Science," PHI, 2004.
2. Rao S.S., "Engineering Optimizations: Theory and Practice", New Age International Pvt. Ltd., 4th Edition, 2009.
3. Douglas B. West, "Introduction to Graph Theory", Prentice Hall of India, 2001.
4. Robin J. Wilson, "Introduction to Graph Theory", Pearson Education 4th edition, 2007.
5. Kalyanmoy Deb, "Optimization for Engineering Design – Algorithms and Design", PHI, 2012.

	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11
CO1	1	3	1	-	-	-	-	-	-	-	-
CO2	-	2	1	-	-	-	-	-	-	-	-
CO3	1	2	2	-	-	-	-	-	-	-	-

Controller of Examinations
Government College of Technology
COIMBATORE - 641 013

16VLPE06 NEURAL NETWORKS (Common to Applied Electronics)	L 3	T 0	P 0	C 3
CORE/ ELECTIVE COURSE: Elective				
PREREQUISITES: • NIL				
COURSE ASSESSMENT METHODS: Both continuous and semester-end assessment.				
COURSE OBJECTIVES: <ul style="list-style-type: none"> • To give an Exposure to artificial neurons, learning and default multi-layered networks & local minima networks. • To have an understanding of global minima networks, associative memories and competitive neural networks. • To Study pattern matching, character recognition and speech recognition neural networks. 				
COURSE OUTCOMES: Upon completion of the course, the students will have: CO1: Exposure to artificial neurons, learning and default multi-layered networks & local minima networks. CO2: Understanding of global minima networks, associative memories and competitive neural networks. CO3: Knowledge on pattern matching, character recognition and speech recognition neural networks.				
TOPICS COVERED: INTRODUCTION TO ARTIFICIAL NEURAL NETWORKS (9) Neuro-physiology - General Processing Element - ADALINE - LMS learning rule - MADALINE - MR2 training algorithm. BPN AND BAM (9) Back Propagation Network - updating of output and hidden layer weights -application of BPN – associative memory - Bi-directional Associative Memory - Hopfield memory - travelling sales man problem. SIMULATED ANNEALING AND CPN (9) Annealing, Boltzmann machine - learning - application - Counter Propagation network - architecture - training - Applications. SOM AND ART (9) Self organizing map - learning algorithm - feature map classifier - applications - architecture of Adaptive Resonance Theory - pattern matching in ART network. NEOCOGNITRON (9) Architecture of Neocognitron - Data processing and performance - architecture of spacio - temporal networks for speech recognition.				

LECTURE: 45 PERIODS TUTORIAL: 0 PERIODS PRACTICAL: 0 PERIODS TOTAL: 45 PERIODS

Reference Books:

1. J.A. Freeman and B.M.Skapura , "Neural Networks, Algorithms Applications and Programming Techniques", Pearson 2011.
2. Laurene Fausett, "Fundamentals of Neural Networks: Architecture, Algorithms and Applications", Pearson education India 2006.
3. Simon Haykin, "Neural Networks & Learning Machines" third edition Pearson Education 2011.

	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11
CO1	3	2	-	2	2	-	-	-	-	-	-
CO2	3	2	-	2	2	-	-	-	-	-	-
CO3	3	3	-	2	2	-	-	-	-	-	-

Controller of Examinations
Government College of Technology
COIMBATORE - 641 013

16VLPE07 ELECTRONIC PACKAGING TECHNOLOGIES (Common to Applied Electronics)	L	T	P	C
	3	0	0	3
CORE/ ELECTIVE COURSE: Elective				
PREREQUISITES:				
<ul style="list-style-type: none"> • Semiconductor Devices 				
COURSE ASSESSMENT METHODS: Both continuous and semester-end assessment.				
COURSE OBJECTIVES:				
<ul style="list-style-type: none"> • To Exposure on IC Packaging with the associated issues like thermal, speed, signal and integrity power etc. • To Knowledge on the appropriate packaging styles and design procedures . • To Knowledge on CAD used in designing wiring boards. 				
COURSE OUTCOMES:				
Upon completion of the course the students will have				
CO1: Exposure on IC Packaging with associated issues like thermal, speed, signal and integrity power etc.				
CO2: Knowledge on the appropriate packaging styles and design procedures.				
CO3: Knowledge on CAD used in designing wiring boards.				
TOPICS COVERED:				
OVERVIEW OF ELECTRONIC SYSTEMS PACKAGING (9)				
Introduction of an Electronic system and history of semiconductors - Products and levels of packaging - Packaging aspects of handheld products - Definition of PWB - Basics of Semiconductor and Process flowchart - Wafer fabrication, inspection and testing - Wafer packaging; Packaging evolution; Chip connection choices, Wire bonding - TAB and flip chip.				
SEMICONDUCTOR PACKAGES (9)				
Single chip packages or modules (SCM) - Commonly used packages and advanced packages - Materials in packages; Thermal mismatch in packages; Multichip modules (MCM)-types; System-in-package (SIP); Packaging roadmaps; Hybrid circuits; Electrical Design considerations in systems packaging, Resistive, Capacitive and Inductive Parasitics - Layout guidelines and the Reflection problem - Interconnection.				
CAD FOR PRINTED WIRING BOARDS (9)				
Benefits from CAD; Introduction to DFM, DFR & DFT, Components of a CAD package and its highlights - Beginning a circuit design with schematic work and component, layout, DFM check, list and design rules; Design for Reliability, Printed Wiring Board Technologies: Board-level packaging aspects, Review of CAD output files for PCB fabrication; Photo plotting and mask generation, Process flow-chart; Vias; PWB substrates; Surface preparation, Photoresist and application methods; UV exposure and developing; Printing technologies for PWBs, PWB etching; Resist stripping; Screen-printing technology, through-hole manufacture process steps; Panel and pattern plating methods, Solder mask for PWBs; Multilayer PWBs; Introduction to, microvias, Microvia technology and Sequential build-up technology process flow for high-				

density, interconnects.

SURFACE MOUNT TECHNOLOGY AND THERMAL CONSIDERATIONS (9)

SMD benefits; Design issues; Introduction to soldering, Reflow and Wave Soldering methods to attach SMDs, Solders; Wetting of solders; Flux and its properties; Defects in wave soldering, Vapour phase soldering, BGA soldering and De-soldering/Repair; SMT failures, SMT failure library and Tin Whisker, Tin-lead and lead-free solders; Phase diagrams; Thermal profiles for reflow soldering; Lead free Alloys, Lead-free solder considerations; Green electronics; RoHS compliance and e-waste recycling, Issues, Thermal Design considerations in systems packaging (L. Umanand, Thermal Design considerations in systems packaging.

EMBEDDED PASSIVES TECHNOLOGY (9)

Introduction to embedded passives - Need for embedded passives - Design Library; Embedded resistor processes - Embedded capacitors - Processes for embedding capacitors.

LECTURE: 45 PERIODS TUTORIAL: 0 PERIODS PRACTICAL: 0 PERIODS TOTAL: 45 PERIODS

Reference Books:

1. Tummala, Rao R., *Fundamentals of Microsystems Packaging*, McGraw Hill Reference Book 2001.
2. Blackwell (Ed), *The electronic packaging handbook*, CRC Press 1999.
3. Tummala, Rao R, *Microelectronics packaging handbook*, McGraw Hill 1997.
4. Bosshart, *Printed Circuit Boards Design and Technology*, Tata McGraw Hill 2002.
5. William D. Brown, "Advanced Electronic Packaging", IEEE Press, 1999.

	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11
CO1	2	1	1	2	2	1	2	2	-	-	1
CO2	2	1	1	2	2	-	2	2	-	-	1
CO3	1	1	1	2	3	-	3	1	-	-	1

Controller of Examinations
Government College of Technology
COIMBATORE - 641 013

16VLPE08 NANO ELECTRONICS (Common to Applied Electronics)	L 3	T 0	P 0	C 3
CORE/ ELECTIVE COURSE: Elective				
PREREQUISITES:				
<ul style="list-style-type: none"> Semiconductor theory. 				
COURSE ASSESSMENT METHODS: Both continuous and semester-end assessment.				
COURSE OBJECTIVES:				
<ul style="list-style-type: none"> To gain knowledge in particles, waves and materials for Nano Electronics. To understand growth, fabrication and measurement techniques for nanostructures. To gain knowledge on Nano Structure and Devices. 				
COURSE OUTCOMES:				
Upon completion of this course the students will have:				
CO 1: Depth knowledge in particles, waves and materials for Nano Electronics.				
CO 2: An ability to understand growth, fabrication and measurement techniques for nanostructures.				
CO3: Knowledge on Nano Structure and Devices.				
TOPICS COVERED:				
PARTICLES, WAVES AND WAVE MECHANICS (9)				
Introduction -Classical particles -Classical waves -Wave-particle duality -Wave mechanics-The Schrodinger wave equation-Wave mechanics of particles-Atoms and atomic orbitals.				
MATERIALS FOR NANOELECTRONICS (9)				
Introduction -Semiconductors -Crystal lattices: bonding in crystals -Electron energy bands - Semiconductor heterostructures - Lattice-matched and pseudomorphic heterostructures - Organic semiconductors -Carbon nonmaterial: nanotubes and fullerenes.				
GROWTH, FABRICATION AND MEASUREMENT TECHNIQUES FOR NANO STRUCTURES (9)				
Bulk crystal and heterostructure growth -Nanolithography, etching, and other means for fabrication of nanostructures and nanodevices -Techniques for characterization of nanostructures -Spontaneous formation and ordering of nanostructures -Clusters and nanocrystals -Methods of nanotube growth - Chemical and biological methods for nanoscale fabrication -Fabrication of nanoelectromechanical systems.				
ELECTRON TRANSPORT IN SEMICONDUCTORS AND NANOSTRUCTURES (9)				
Time and length scales of the electrons in solids -Statistics of the electrons in solids and nanostructures - The density of states of electrons in nanostructures -Electron transport in nanostructures. Electrons in traditional low-dimensional structures- Electrons in quantum wells -Electrons in quantum wires - Electrons in quantum dots.				
NANOSTRUCTURE DEVICE (9)				
Resonant-tunneling diodes - Field-effect transistors -Single-electron-transfer devices -Potential-effect transistors -Light-emitting diodes and lasers -Nanoelectromechanical system devices -dot cellular automata.				
LECTURE: 45 PERIODS TUTORIAL: 0 PERIODS PRACTICAL: 0 PERIODS TOTAL: 45 PERIODS				

Reference Books:

1. Vladimir V. Mitin, Viatcheslav A. Kochelap, Michael A. Stroschio, "Introduction to Nanoelectronics: Science, Nanotechnology, Engineering, and Applications", Cambridge University Press 2011.
2. Supriyo Datta, "Lessons from Nanoelectronics: A New Perspective on Transport", World Scientific 2012.
3. George W. Hanson, "Fundamentals of Nanoelectronics", Pearson 2009.
4. Mircea Dragoman, Daniela Dragoman, "Nanoelectronics: principles and devices", CRC Press 2006.
5. Karl Goser, Peter Glösekötter, Jan Dienstuhl, "Nanoelectronics and Nanosystems: From Transistors to Molecular and Quantum Devices", Springer 2004.
6. Mark A. Reed, Takhee Lee, "Molecular nanoelectronics", American Scientific Publishers 2003.
7. Jaap Hoekstra, "Introduction to Nanoelectronic Single-Electron Circuit Design", Pan Stanford Publishing 2010.
8. W. Ranier, "Nano Electronics and Information Technology", John Wiley & Sons 2012.

	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11
CO1	3	1	2	1	3	2	-	1	1	-	1
CO2	2	2	1	1	2	-	2	-	1	1	2
CO3	1	1	3	2	2	1	-	1	1	-	1

Controller of Examinations
Government College of Technology
COIMBATORE - 641 013

16VLPE09 REAL TIME OPERATING SYSTEM (Common to Applied Electronics)	L	T	P	C
	3	0	0	3
CORE/ELECTIVE COURSE: Elective				
PREREQUISITES:				
<ul style="list-style-type: none"> Operating System. 				
COURSE ASSESSMENT METHODS: Both continuous and semester-end assessment..				
COURSE OBJECTIVES:				
<ul style="list-style-type: none"> To learn issues related to the design and analysis of systems with real time Constraints and features of Real time OS. To learn about various Uniprocessor and Multiprocessor scheduling mechanisms. To get knowledge on real time communication protocols. 				
COURSE OUTCOMES:				
Upon completion of this course, the students will have:				
CO1: Knowledge on issues related to the design and analysis of systems with real time Constraints and features of Real time OS.				
CO2: Ability to analyze various Uniprocessor and multiprocessor scheduling mechanism.				
CO3: Knowledge on real time communication protocols.				
TOPICS COVERED:				
INTRODUCTION TO REAL TIME OPERATING SYSTEM (9)				
Introduction to Real time computing Concepts; Example of real time applications-Structure of a real time system-Characterization of real time systems and tasks- Hard and Soft timing constraints -Design challenges- Performance metrics -Prediction of Execution time: Source code analysis, Micro -architecture level analysis, Cache and pipeline issues -Programming Languages for Real -Time System.				
REVIEW OF RTOS (9)				
Real time OS-Threads and Tasks-Structure of Microkernel-Time services-Scheduling Mechanisms Communication and Synchronization-Event Notification and Software interrupt.				
TASK SCHEDULING AND ALGORITHMS (9)				
Task assignment and Scheduling -Task allocation algorithms- Single processor and Multiprocessor task scheduling- Clock driven and Priority based scheduling algorithms -Fault tolerant Scheduling.				
REAL TIME PROTOCOLS (9)				
Real Time Communication Network-Topologies and architecture issues-protocols-contension based, token based, polled bus, deadline based protocol, Fault tolerant routing.RTP and RTCP.				
REAL TIME DATABASES (9)				
Real time Databases-Transaction priorities-Concurrency control issues-Disk scheduling algorithms-Two phase approach to improve predictability.				
LECTURE: 45 PERIODS TUTORIAL: 0 PERIODS PRACTICAL: 0 PERIODS TOTAL: 45 PERIODS				

Reference Books:

1. Jane W.S. Liu, *Real Time Operating Systems*, Pearson Education India, 2000.
2. Philip A. Laplante and Seppo J. Ovaska, "*Real Time Operating Systems Design and Analysis: Tools for the Practitioner*" IV Edition IEEE Press, Wiley, 2013.
3. C.M. Krishna, Kang G. Shin "*Real Time Operating Systems*", International Edition, McGraw Hill Companies, Inc., New York, 2013.

	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11
CO1	3	3	2	2	2	2	-	1	2	2	-
CO2	3	3	2	2	2	2	-	1	2	3	-
CO3	3	3	2	2	2	2	-	1	2	2	-

Controller of Examinations
Government College of Technology
COIMBATORE - 641 013

16VLPE10 EMBEDDED CONTROLLERS	L	T	P	C
3 0 0 3				
<i>CORE/ ELECTIVE COURSE:</i> Elective				
<i>PREREQUISITES:</i>				
• NIL				
<i>COURSE ASSESSMENT METHODS:</i> Both continuous and semester-end assessment.				
<i>COURSE OBJECTIVES:</i>				
<ul style="list-style-type: none"> • To learn about the designing of an embedded system for commercial applications. • To learn the features, architecture and programming of PIC microcontrollers. • To learn the features, architecture and programming of MSP430 microcontrollers. • Interfacing Input/output devices with the PIC and MSP430 microcontroller. 				
<i>COURSE OUTCOMES:</i>				
Upon completion of this course, the students will have:				
CO1:Ability to design and develop embedded systems for a given problem.				
CO2:Ability to develop embedded system for entertainment, communication and medical applications.				
CO3:Ability to build and trouble shoot embedded systems.				
TOPICS COVERED:				
8-BIT CONTROLLER (9)				
Microprocessors and microcontrollers, introducing PIC 16F877- architecture, memory technologies, timing circuits, power-up and reset, parallel ports, ADC, interrupt, serial peripheral buses (UART, I2C, SPI), PWM, counters and timers, instruction set and assembly language programming.				
PIC DEVELOPMENT TOOLS AND PROGRAMMING (9)				
Software development tools- editor, assembler, compiler, cross-compiler and simulator, Hardware development tools- development board, device programmer, in-circuit emulator and debuggers. Embedded C Programming, data types and variables, data type modifiers, storage Class modifiers, C statements, structures and operations, pointers, libraries, in-line assembly programming, optimizing and testing embedded C programs.				
PERIPHERAL INTERFACING WITH PIC MICROCONTROLLER (9)				
Human and physical interfaces- switches to keyboard, LED display, liquid crystal display, Actuators and sensors, PWM, serial communication protocols (UART, I2C, SPI), programming interrupt, timers and counter.				
16-BIT CONTROLLER (9)				
MSP430 – Introduction to Architecture - Embedded C Programming in MSP430 – GPIO Pins & Configuration Timers, Capture, & PWM DAC- ADCs –Memory System-Flash Memory-DMA.				
MSP 430 Interfacing (9)				
USCI Port –SPI mode - I2C Mode-UART Mode & RS232 Low Power Mode Operation- Interfacing- Input Devices-Output Devices-DC Motor-Stepper Motor- Alarm interface- AC Devices.				
LECTURE: 45 PERIODS TUTORIAL: 0 PERIODS PRACTICAL: 0 PERIODS TOTAL: 45 PERIODS				

Reference Books:

1. Kirk Zurell, "C programming for Embedded Systems", CRC Press, 2000.
2. Dogan Ibrahim, "Advanced PIC microcontroller projects in C", Newnes publication, 2012.
3. Tim Wilmshurst, "Designing Embedded Systems with PIC microcontrollers-Principles and Applications", Newnes Publications, 2007.
4. Muhammad Ali Mazidi, Rolin McKinlay, Danny Causey, "PIC Microcontroller and Embedded Systems: Using Assembly and C for PIC18", Prentice hall publications, 2007.
5. Martin Bates, "Interfacing PIC microcontrollers-Embedded Design by Interactive Simulation", Newnes Publication, 2006.
6. John H. Davies "MSP430 Microcontrollers Basics", Elsevier Limited 2008.
7. Steven Barrett, Daniel Pack, "Microcontroller Programming and Interfacing TI MSP430, Part 1", Morgan and Claypool, 2011.

	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11
CO1	2	-	2	-	1	-	-	-	2	-	-
CO2	1	-	3	-	2	-	-	-	2	-	-
CO3	-	-	-	2	2	1	1	-	-	-	3

Controller of Examinations
Government College of Technology
COIMBATORE - 641 013

16VLPE11 HIGH PERFORMANCE COMPUTER NETWORKS	L 3	T 0	P 0	C 3
<i>CORE/ ELECTIVE COURSE:</i> Elective				
PREREQUISITE • Knowledge in Computer Networks				
COURSE ASSESSMENT METHODS: Both continuous and semester-end assessment				
COURSE OBJECTIVES: • To ensure a comprehensive understanding of high speed computer network architectures • To study mathematical models related to network performance analysis. • To focus on current and emerging networking Technologies.				
COURSE OUTCOMES: The upon completion of this course students will have ability: CO1:To design and implement network protocols in HPCN. CO2:To analyze performance of network related issues using mathematical models. CO3:To compare the various methods of providing connection-oriented services over an advanced network with reference to MPLS, VPN.				
TOPICS COVERED: SWITCHING NETWORKS (9) Switching – Packet switching - Ethernet, Token Ring, FDDI, DQDB, Frame Relay, SMDS, Circuit Switched – SONET, DWDM, DSL, Intelligent Networks – CATV, ATM – Features, Addressing Signaling & Routing, Header Structure, ATM Adaptation layer, Management control, BISDN, Internetworking with ATM. MULTIMEDIA NETWORKING APPLICATIONS (9) Streaming stored Audio and Video, Best effort service, protocols for real time interactive applications, Beyond best effort, scheduling and policing mechanism, integrated services, RSVP- differentiated services. ADVANCED NETWORKS CONCEPTS (9) VPN-Remote-Access VPN, site-to-site VPN, Tunneling to PPP, Security in VPN.MPLS-operation, Routing, Tunneling and use of FEC, Traffic Engineering, and MPLS based VPN, overlay networks-P2P connections.- IPv4 vs V6. PACKET QUEUES AND DELAY ANALYSIS (9) Little 's theorem, Birth and Death process, queueing discipline- Control & stability -, Markovian FIFO queueing system, Non-markovian - Pollaczek-Khinchin formula and M/G/1, M/D/1, self-similar models and Batch-arrival model, Networks of Queues – Burke's theorem and Jackson Theorem. NETWORK SECURITY AND MANAGEMENT (9) Principles of cryptography – Elliptic-AES- Authentication – integrity – key distribution and certification – Access control and: fire walls – DoS-attacks and counter measures – security in many layers. Infrastructure for network management – The internet standard management framework – SMI, MIB, SNMP, Security and administration – ASN.1.				
LECTURE: 45 PERIODS TUTORIAL: 0 PERIODS PRACTICAL: 0 PERIODS TOTAL: 45 PERIODS				

Reference Books:

1. Aunurag Kumar, D. Manjunath, Joy Kuri, "Communication Networking", Morgan Kaufmann Publishers, 2011.
2. J.F. Kurose & K.W. Ross, "Computer Networking- A Top Down Approach Featuring the Internet", Pearson Education, 2nd Edition, 2003.
3. Nader F.Mir, "Computer and Communication Networks", Pearson Education, 2009.
4. Walrand .J. Varatya, "High Performance Communication Network", Morgan Kaufmann – Harcourt Asia Pvt. Ltd., 2nd Edition, 2000.
5. Hersent Gurle & Petit, "IP Telephony, Packet Pored Multimedia Communication Systems", Pearson Education 2003.
6. Fred Halsall and Lingana Gouda Kulkarni, "Computer Networking and the Internet", Fifth Edition, Pearson Education, 2012.
7. Larry L.Peterson & Bruce S.David, "Computer Networks: A System Approach"- Morgan Kaufmann Publisher, 1996.

	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11
CO1	1	-	3	-	-	1	-	-	2	-	-
CO2	1	-	-	-	3	-	-	-	2	-	-
CO3	-	-	-	2	-	-	-	1	1	-	-

Controller of Examinations
Government College of Technology
COIMBATORE - 641 013

16VLPE12 ANALYSIS AND DESIGN OF ANALOG INTEGRATED CIRCUITS	L	T	P	C
	3	0	0	3
CORE/ ELECTIVE COURSE: Core				
PREREQUISITES:				
<ul style="list-style-type: none"> Analog integrated circuits. 				
COURSE ASSESSMENT METHODS: Both continuous and semester-end assessment.				
COURSE OBJECTIVES:				
<ul style="list-style-type: none"> To acquire knowledge on circuit configuration for linear integrated circuits and multiple transistor amplifier. To analyze nonlinear analog circuits. To analyze and design Operational amplifier. 				
COURSE OUTCOMES:				
Upon completion of this course, the students will have:				
CO1: Knowledge on circuit configuration for linear integrated circuits and multiple transistor amplifiers.				
CO2: Ability to analyze nonlinear analog circuits.				
CO3: Ability to analyze and design Operational amplifier.				
TOPICS COVERED:				
CIRCUIT CONFIGURATION FOR LINEAR IC (9)				
Current Sources-General Properties-Simple Current Mirror with beta helper-Simple current mirror with degeneration-Cascode Current Mirror-Wilson Current MIRROR- Widlar current source-Supply Insensitive Biasing-Temperature Insensitive Biasing. Output Stages - Emitter and source followers, Push pull output stages.				
SINGLE TRANSISTOR AND MULTIPLE TRANSISTOR AMPLIFIER (9)				
Basic single transistor amplifier stages -CE, CB, CC configuration- Multiple transistor amplifier stage – active cascode configuration, differential pairs – Emitter coupled pair.				
OPERATIONAL AMPLIFIER (9)				
Analysis of operational amplifier circuit, Slew rate model and High Frequency Analysis - Operational Amplifier noise.				
NON LINEAR ANALOG CIRCUITS (9)				
Precision Rectification-Analysis of four quadrant and variable trans conductance multiplier-Application of Gilbert cell. Balanced Modulator - Closed loop analysis of PLL - Voltage Controlled Oscillator.				
ANALOG DESIGN WITH MOS TECHNOLOGY (9)				
MOS Current Mirror-Simple, Cascode, Widlar and Wilson Current source-MOS Supply Insensitive Biasing. MOS amplifier, source coupled pair and basic two stage MOS opamps.				

LECTURE: 45 PERIODS TUTORIAL: 0 PERIODS PRACTICAL: 0 PERIODS TOTAL: 45 PERIODS

Reference Books:

1. Schaumont, Patrick, "A Practical Introduction to Hardware/ Software Co-Design", 2013.
2. Ralf Niemann, "Hardware/Software Co-Design for Data Flow Dominated Embedded Systems", Kluwer Academic Pub, 2015.
3. Jorgen Staunstrup, Wayne Wolf, "Hardware/Software Co-Design: Principles and Practice", Kluwer Academic Pub, 2015.
4. Giovanni De Micheli, Rolf Ernst Morgon, "Reading in Hardware/Software Co-Design" Kaufmann Publishers, 2001.

	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11
CO1	3	2	2	2	2	2	-	1	2	1	-
CO2	3	2	2	2	2	2	-	1	2	1	-
CO3	3	2	2	2	2	2	-	1	2	1	-

Controller of Examinations
Government College of Technology
COIMBATORE - 641 013

16VLPE13 DSP INTEGRATED CIRCUITS	L	T	P	C
	3	0	0	3
CORE/ ELECTIVE COURSE: Elective				
PREREQUISITES:				
<ul style="list-style-type: none"> Digital Signal Processing. 				
COURSE ASSESSMENT METHODS: Both continuous and semester-end assessment.				
COURSE OBJECTIVES:				
<ul style="list-style-type: none"> To gain Basic knowledge of Digital Signal Processing, Discrete Time Transforms and VLSI circuit technologies. To get exposure to digital filters, multi rate signal processing and finite word length effects. To Understand the principle of state of art DSP architectures and design of arithmetic units. 				
COURSE OUTCOMES:				
Upon completion of the course students will have				
CO1: Basic knowledge of Digital Signal Processing, Discrete Time Transforms and VLSI circuit technologies.				
CO2: Exposure to digital filters, multi rate signal processing and finite word length effects.				
CO3: Understanding of the principle of state of art DSP architectures and design of arithmetic units.				
TOPICS COVERED:				
NUMBERS SYSTEMS, ARITHMATIC UNITS AND INTEGRATED CIRCUITS (9)				
Conventional number system - Redundant Number system - Residue Number System .Bit-parallel and Bit-Serial arithmetic - Distributed Arithmetic - Basic shift accumulator - Reducing the memory size - Complex multipliers - Improved shift-Accumulator.				
DIGITAL SIGNAL PROCESSING (9)				
Digital signal processing - Sampling of analog signals - Selection of sample frequency - Signal-processing systems - Frequency response - Transfer functions - Signal flow graphs - Filter structures - Adaptive DSP algorithms - FFT-The Fast Fourier Transform Algorithm - Image coding - Discrete cosine transforms.				
DIGITAL FILTERS AND FINITE WORD LENGTH EFFECTS (9)				
FIR filters - FIR filter structures - FIR chips - IIR filters - Specifications of IIR filters - Multirate systems - Interpolation with an integer factor L - Sampling rate change with a ratio L/M - Multirate filters. Finite word length effects -Parasitic oscillations - Scaling of signal levels - Round-off noise - Measuring round-off noise - Coefficient sensitivity - Sensitivity and noise.				
DSP INTEGRATED CIRCUITS AND VLSI CIRCUIT TEHNOLOGIES (9)				
Standard digital signal processors - Application specific IC's for DSP - DSP systems - DSP system design - Integrated circuit design. MOS transistor - MOS logic - VLSI process technologies - Trends in CMOS technologies.				
DSP ARCHITECTURES AND SYNTHESIS (9)				
DSP system architectures - Standard and Ideal DSP architecture - Multiprocessors and multi computers -				

Systolic and Wave front arrays - Mapping of DSP algorithms onto hardware - Implementation based on complex PEs - Shared memory architecture with Bit – serial PEs - Layout of VLSI circuits - FFT processor - DCT processor and Interpolator as case studies.

LECTURE: 45 PERIODS TUTORIAL: 0 PERIODS PRACTICAL: 0 PERIODS TOTAL: 45 PERIODS

Reference Books

1. Lars Wanhammer, “**DSP Integrated Circuits**”, Academic press, New York 2001.
2. A.V.Oppenheim et.al, “**Discrete-time Signal Processing**”, Pearson education, 2014.
3. Emmanuel C. Ifeakor, Barrie W. Jervis, “**Digital signal processing–A practical approach**”, 2nd edition, Harlow Prentice Hall, 2011.
4. Keshab K.Parhi, „**VLSI digital Signal Processing Systems design and Implementation**”, JohnWiley & Sons, 2007.

	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11
CO1	3	2	-	2	2	-	-	-	-	-	-
CO2	3	2	-	2	2	-	-	-	-	-	-
CO3	3	2	-	2	3	-	-	-	-	-	-

Controller of Examinations
 Government College of Technology
 COIMBATORE - 641 013

16VLPE14 HARDWARE SOFTWARE CO-DESIGN	L 3	T 0	P 0	C 3
CORE/ELECTIVE COURSE: Elective				
PREREQUISITES: • ASIC, Embedded Systems.				
COURSE ASSESSMENT METHODS: Both continuous and semester-end assessment				
COURSE OBJECTIVES: • To study and compare the co-design approaches for single processor and multiprocessor architectures. • To know the various techniques of prototyping and emulation. • To study the languages for system level specification and design				
COURSE OUTCOMES: Upon completion of the course, the students will have: CO1: Knowledge on Co-design approaches for single processor and multiprocessor Architectures. CO2: Ability to apply the various techniques of prototyping and emulation. CO3: Knowledge on the languages for system level specification and design.				
TOPICS COVERED: SYSTEM SPECIFICATION AND MODELLING (9) Embedded Systems - Hardware/Software Co-Design, Co - Design for System Specification and Modelling, Co - Design for Heterogeneous Implementation - Processor Synthesis - Single Processor Architectures with single ASIC - Single Processor Architectures with many ASICs - Multi-Processor Architectures - Comparison of Co-Design Approaches - Models of Computation - Requirements for Embedded System Specification. HARDWARE/SOFTWARE PARTITIONING (9) The Hardware/Software Partitioning Problem - Hardware-Software Cost Estimation - Generation of the Partitioning Graph - Formulation of the Hardware-Software Partitioning Problem – Optimization - Hardware-Software Partitioning based on Heuristic Scheduling - Hardware-Software Partitioning based on Genetic Algorithms. HARDWARE/SOFTWARE CO-SYNTHESIS (9) The Co-Synthesis Problem - State Transition Graph - Refinement and Controller Generation - Distributed System Co-Synthesis. PROTOTYPING AND EMULATION (9) Introduction - Prototyping and Emulation Techniques - Prototyping and Emulation Environments - Future Developments in Emulation and Prototyping - Target Architecture - Architecture Specialization Techniques - System Communication Infrastructure - Target Architectures and Application System				

Classes - Architectures for Control-Dominated Systems - Architectures for Data-Dominated Systems - Mixed Systems and Less Specialized Systems.

DESIGN SPECIFICATION AND VERIFICATION (9)

Concurrency, Coordinating Concurrent Computations - Interfacing Components, Verification - Languages for System-Level Specification and Design - System Level Specification - Design Representation for System Level Synthesis - System Level Specification Languages - Heterogeneous Specification and Multi-Language Co- simulation.

LECTURE: 45 PERIODS TUTORIAL: 0 PERIODS PRACTICAL: 0 PERIODS TOTAL: 45 PERIODS

Reference Books:

- 1.Schaumont, Patrick, "A Practical Introduction to Hardware/ Software Co-Design",2013.
- 2.Ralf Niemann, "Hardware/Software Co-Design for Data Flow Dominated Embedded Systems", Kluwer Academic Pub, 2015.
- 3.Jorgen Staunstrup, Wayne Wolf, "Hardware/Software Co-Design: Principles and Practice", Kluwer Academic Pub, 2015.
- 4.Giovanni De Micheli, Rolf Ernst Morgon," Reading in Hardware/Software Co-Design" Kaufmann Publishers, 2001.

	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11
CO1	2	2	1	2	3	1	2	2	-	-	1
CO2	2	2	1	3	3	1	3	2	-	-	1
CO3	2	1	-	3	3	-	2	1	-	-	1

Controller of Examinations
Government College of Technology
COIMBATORE - 641 013

16VLPE15 DESIGN OF SEMICONDUCTOR MEMORIES	L	T	P	C
	3	0	0	3
CORE/ ELECTIVE COURSE: Elective				
PREREQUISITES:				
<ul style="list-style-type: none"> • Computer Architecture, Digital System Design. 				
COURSE ASSESSMENT METHODS: Both continuous and semester-end assessment.				
COURSE OBJECTIVES:				
<ul style="list-style-type: none"> • To study the architectures for SRAM and DRAM. • To know about various non-volatile memories. • To study the fault modeling and testing of memories for fault detection. • To learn the radiation hardening process and issues for memory. 				
COURSE OUTCOMES:				
Upon completion of the course, the students will have:				
CO1: Knowledge on the architectures for SRAM, DRAM and various non-volatile memories.				
CO2: Knowledge on fault modeling and testing of memories for fault detection.				
CO3: Exposure on the radiation hardening process and issues for memory.				
TOPICS COVERED:				
RANDOM ACCESS MEMORY TECHNOLOGIES (9)				
Static Random Access Memories (SRAMs): SRAM Cell Structures - MOS SRAM Architecture –MOS SRAM Cell and Peripheral Circuit Operation - Bipolar SRAM Technologies - Silicon On Insulator (SOI) Technology - Advanced SRAM Architectures and Technologies - Application Specific SRAMs. Dynamic Random Access Memories (DRAMs): DRAM Technology Development - CMOS DRAMs-DRAMs Cell Theory and Advanced Cell Structures - BiCMOS, DRAMs - Soft Error Failures in DRAMs - Advanced DRAM Designs and Architecture - Application Specific DRAMs.				
NON VOLATILE MEMORIES (9)				
Masked Read-Only Memories (ROMs) - High Density ROMs - Programmable Read-Only Memories (PROMs) - Bipolar PROMs - CMOS PROMs - Erasable (UV) - Programmable Read-Only Memories (EPROMs) - Floating-Gate EPROM Cell-One-Time Programmable (OTP) EPROMs-Electrically Erasable PROMs (EEPROMs) - EEPROM Technology and Architecture - Nonvolatile SRAM -Flash Memories (EPROMs or EEPROM) - Advanced Flash Memory Architecture.				
MEMORY FAULT MODELING, TESTING, MEMORY DESIGN FOR TESTABILITY AND FAULT TOLERANCE (9)				
RAM Fault Modeling, Electrical Testing, Pseudo Random Testing - Megabit DRAM Testing Nonvolatile Memory Modeling and Testing - IDDQ Fault Modeling and Testing - Application Specific Memory Testing. General Design for Testability Techniques – Ad Hoc Design Techniques, Structured Design Techniques – RAM Built-In Self – Test (BIST).				
RELIABILITY AND RADIATION EFFECTS (9)				
General Reliability Issues - RAM Failure Modes and Mechanism - Nonvolatile Memory Reliability - Reliability Modeling and Failure Rate Prediction - Design for Reliability - Reliability Test Structures - Reliability Screening and Qualification. Radiation Effects - Single Event Phenomenon (SEP) - Radiation Hardening Techniques Radiation Hardening Process and Design Issues - Radiation Hardened Memory				

Characteristics - Radiation Hardness Assurance and Testing – Radiation Dosimetry - Water Level Radiation Testing and Test Structures.

PACKAGING TECHNOLOGIES (9)

Random Access Memories (MRAMs) - Experimental Memory Devices. Memory Hybrids and MCMs (2D) - Memory Stacks and MCMs (3D) - Memory MCM Testing and Reliability Issues - Memory Cards -High Density Memory Packaging Future Directions.

LECTURE: 45 PERIODS TUTORIAL: 0 PERIODS PRACTICAL: 0 PERIODS TOTAL: 45 PERIODS

Reference Books:

1. Ashok K. Sharma, " *Semiconductor Memories Technology, Testing and Reliability* ", Prentice Hall of India Private Limited, New Delhi, 2003.
2. Tegze P. Haraszti, " *CMOS Memory Circuits* ", Kluwer Academic publishers, 2002.
3. Betty Prince, " *Emerging Memories: Technologies and Trends* ", Kluwer Academic publishers, 2002.

	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11
CO1	3	2	1	3	3	2	1	2	-	-	1
CO2	3	2	-	3	3	2	-	2	-	-	1
CO3	2	2	-	3	3	2	-	1	-	-	1

Controller of Examinations
Government College of Technology
COIMBATORE - 641 013

16VLPE16 SYSTEM ON CHIP	L	T	P	C
	3	0	0	3
CORE/ ELECTIVE COURSE: Elective				
PREREQUISITES:				
<ul style="list-style-type: none"> Digital Electronics. 				
COURSE ASSESSMENT METHODS: Both continuous and semester-end assessment.				
COURSE OBJECTIVES:				
<ul style="list-style-type: none"> Ability to design combinational and sequential logic networks. To gain knowledge on optimization of power in combinational and sequential logic machines. Ability to design FPGA and PLA and Knowledge on floor planning methods for system design. 				
COURSE OUTCOMES:				
Upon completion of this course, the students will have:				
CO 1: Ability to design combinational and sequential logic networks.				
CO 2: Knowledge on optimization of power in combinational and sequential logic machines.				
CO 3: Ability to design FPGA and PLA and Knowledge on floor planning methods for system design.				
TOPICS COVERED:				
LOGIC GATES				(9)
Introduction. Combinational Logic Functions. Static Complementary Gates. Switch Logic. Alternative Gate Circuits. Low-Power Gates. Delay Through Resistive Interconnect. Delay Through Inductive Interconnect.				
COMBINATIONAL LOGIC NETWORKS				(9)
Introduction. Standard Cell-Based Layout. Simulation. Combinational Network Delay. Logic and interconnect Design. Power Optimization. Switch Logic Networks. Combinational Logic Testing.				
SEQUENTIAL MAC				(9)
Introduction. Latches and Flip-Flops. Sequential Systems and Clocking Disciplines. Sequential System Design. Power Optimization. Design Validation. Sequential Testing.				
SUBSYSTEM DESIGN				(9)
Introduction. Subsystem Design Principles. Combinational Shifters. Adders. ALUs. Multipliers. High-Density Memory. Field Programmable Gate Arrays. Programmable Logic Arrays. References.Problems.				
FLOOR-PLANNING				(9)
Introduction, Floor-planning Methods – Block Placement & Channel Definition, Global Routing,switchbox Routing, Power Distribution, Clock Distributions, Floor-planning Tips, Design Validation. Off-Chip Connections – Packages, The I/O Architecture, PAD Design.				
LECTURE: 45 PERIODS TUTORIAL: 0 PERIODS PRACTICAL: 0 PERIODS TOTAL: 45 PERIODS				

Controller of Examinations
 Government College of Technology
 COIMBATORE - 641 013

Reference Books:

1. Wayne Wolf, "Modern VLSI Design – System – on – Chip Design", Prentice Hall, 3rd Edition 2008.
2. Wayne Wolf, "Modern VLSI Design – IP based Design", Prentice Hall, 4th Edition , 2008.

	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11
CO1	3	2	-	2	2	-	-	1	-	1	-
CO2	3	2	-	2	2	-	-	1	-	1	-
CO3	2	2	-	2	3	-	-	1	-	1	-

Controller of Examinations
Government College of Technology
COIMBATORE - 641 013

16VLPE17 RECONFIGURABLE ARCHITECTURE FOR VLSI	L 3	T 0	P 0	C 3
CORE/ELECTIVE COURSE: Elective				
PREREQUISITES: <ul style="list-style-type: none"> • VLSI design automation. • ASIC design. 				
COURSE ASSESSMENT METHODS: Both continuous and semester-end assessment.				
COURSE OBJECTIVES: <ul style="list-style-type: none"> • To gain knowledge on run time computing and its applications to VLSI. • To learn optical reconfigurable models. • To understand various multi core architecture. 				
COURSE OUTCOMES: Upon completion of this course the students will have ability to: CO1: Gain knowledge on run time computing and its applications to VLSI. CO2: Learn optical reconfigurable models. CO3: Understand various multi core architectures.				
TOPICS COVERED: RECONFIGURABLE COMPUTING HARDWARE (9) Logic- computational fabric, Array and interconnect-Extended logic Configuration-Reconfigurable processing fabric architectures-RPF integration into traditional computing systems- operating system support for reconfigurable computing- Evolvable FPGA. MAPPING DESIGNS INTO RECONFIGURABLE PLATFORMS (9) Structural mapping- integrated mapping- mapping for heterogeneous resources-Placement problem – clustering- simulated annealing – partition based placement – analytical placement- partitioning for granularity partitioning of parallel programs- instance specific design. COMPUTATIONAL ARCHITECTURES FOR FPGA (9) Precision analysis for fixed point computation- Distributed arithmetic for FPGA – CORDIC architectures for FPGA- Boolean satisfiability – SAT solvers. OPTICAL RECONFIGURATION MODELS (9) Simulation and scalability- Models, Basic algorithmic techniques- optical models – complexities of optical models- run time reconfigurability- Design and implementation. MULTI CORE ARCHITECTURES (9) Multi core and many core architectures-state of the art multi core operating systems-parallelism and performance analysis. LECTURE: 45 PERIODS TUTORIAL: 0 PERIODS PRACTICAL: 0 PERIODS TOTAL: 45 PERIODS				

Reference Books:

1. Scott Hauck, André Dehon, "**Reconfigurable computing: the theory and practice of FPGA-based computation**", Morgan Kaufmann publishers, 2008.
2. Ramachandran Vaidhyamathan and Jerry. L. Trahan "**Dynamic Reconfiguration: Architectures and Algorithms**", Kluwer Academic publishers, 2003.
3. C. Bobda, "**Introduction to Reconfigurable Computing: Architectures, Algorithms and Applications**", Springer, 2007.
4. Andras Vajda, "**Programming many core chips**", Springer, 2011.

	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11
CO1	3	3	3	3	2	2	1	1	-	-	-
CO2	3	3	3	2	2	1	-	-	1	-	-
CO3	3	2	2	2	1	1	1	-	-	-	1

Controller of Examinations
Government College of Technology
COIMBATORE - 641 013

16VLPE18 VLSI INTERCONNECTS AND ITS DESIGN TECHNIQUES	L	T	P	C
	3	0	0	3
CORE/ ELECTIVE COURSE: Elective				
PREREQUISITES:				
• NIL.				
COURSE ASSESSMENT METHODS: Both continuous and semester-end assessment.				
COURSE OBJECTIVES:				
<ul style="list-style-type: none"> To gain knowledge on VLSI Interconnects. To get an insight on Transmission line parameters of VLSI interconnects. To understand the novel solutions on interconnects. 				
COURSE OUTCOMES:				
Upon completion of this course the students will have:				
CO 1: Basic knowledge on VLSI Interconnects.				
CO 2: Exposure to Transmission line parameters of VLSI interconnects.				
CO 3: To create Novel solutions on Interconnects.				
TOPICS COVERED:				
PRELIMINARY CONCEPTS OF VLSI INTERCONNECTS (9)				
Interconnects for VLSI applications-copper interconnections –method of images- method of moments-even and odd capacitances- transmission line equations- miller’s theorem- Resistive interconnects as ladder network Propagation modes in micro strip interconnects- slow wave propagations Propagation delay.				
PARASITIC RESISTANCES, CAPACITANCE AND INDUCTANCES (9)				
Parasitic resistances, capacitances and inductances- approximate formulas for inductances- green’s function method: using method of images and Fourier integral approach- network Analog method- Inductance extraction using fast Henry- copper interconnections for resistance modeling .				
INTERCONNECTION DELAYS (9)				
Metal insulator semiconductor micro strip line- transmission line analysis for single level interconnections- transmission line analysis for parallel multilevel interconnections- analysis of crossing interconnections- parallel interconnection models for micro strip line- modeling of lossy parallel and crossing interconnects- high frequency losses in micro strip line- Expressions for interconnection delays- Active interconnects.				
CROSS TALK ANALYSIS (9)				
Lumped capacitance approximation- coupled multi conductor MIS micro strip line model for single level interconnects- frequency domain level for single level interconnects- transmission line level analysis of parallel multi level interconnections.				
NOVEL SOLUTIONS FOR PROBLEMS IN INTER (9)				
Optical interconnects – carbon Nano tubes / Graphenes vs. Copper wires.				
LECTURE: 45 PERIODS TUTORIAL: 0 PERIODS PRACTICAL: 0 PERIODS TOTAL: 45 PERIODS				

Reference Books:

1. H B Bakog Lu, Circuits, "Interconnections and packaging for VLSI", Addison Wesley publishing company.
2. J A Davis, J D Meindl, "Interconnect technology and design for Gigascale integration", Kluwer academic publishers.
3. Nurmi J, Tenhunen H, Isoaho J, Jantsch A, "Interconnect Centric deisgn for advanced SOC and NOC", Springer.
4. C K Cheng, J Lillis, S Lin, N Chang, "Interconnect analysis and synthesis", Wiley inter-science.
5. Hall S H, G W Hall and J McCall, High speed digital system design, Wiley inter-science.
6. Askok K Goel, "High speed VLSI interconnections", Wiley interscience, second edition, 2007.

	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11
CO1	3	2	1	3	3	2	1	2	-	-	1
CO2	3	2	-	3	3	2	-	2	-	-	1
CO3	2	2	-	3	3	2	-	1	-	-	1

Controllor of Examinations
Government College of Technology
COIMBATORE - 641 013

16VLPE19 VLSI FOR WIRELESS COMMUNICATION	L 3	T 0	P 0	C 3
CORE/ ELECTIVE COURSE: Elective				
PREREQUISITES: • NIL				
COURSE ASSESSMENT METHODS: Both continuous and semester-end assessment.				
COURSE OBJECTIVES: • To study the design concepts of low noise amplifiers. • To study the various types of mixers designed for wireless communication. • To study and design PLL and VCO. • To understand the concepts of CDMA in wireless communication.				
COURSE OUTCOMES: Upon completion of this course, the students will have ability: CO1:To study the design concepts of low noise amplifiers. CO2:To study and design frequency synthesis and subsystems. CO3:To understand the concepts of CDMA in wireless communication.				
TOPICS COVERED: COMPONENTS AND DEVICES (9) Integrated inductors, resistors, MOSFET and BJT AMPLIFIER DESIGN: Low Noise Amplifier Design - Wideband LNA - Design Narrowband LNA - Impedance Matching - Automatic Gain Control Amplifiers – Power Amplifiers. MIXERS (9) Balancing Mixer - Qualitative Description of the Gilbert Mixer - Conversion Gain – Distortion – Low Frequency Case: Analysis of Gilbert Mixer – Distortion – High Frequency Case – Noise – A Complete Active Mixer. Switching Mixer - Distortion in Unbalanced Switching Mixer – Conversion Gain in Unbalanced Switching Mixer - Noise in Unbalanced Switching Mixer - A Practical Unbalanced Switching Mixer. Sampling Mixer - Conversion Gain in Single Ended Sampling Mixer - Distortion in Single Ended Sampling Mixer - Intrinsic Noise in Single Ended Sampling Mixer - Extrinsic Noise in Single Ended Sampling Mixer. FREQUENCY SYNTHESIZERS (9) Phase Locked Loops - Voltage Controlled Oscillators - Phase Detector – Analog Phase Detectors – Digital Phase Detectors - Frequency Dividers - LC Oscillators - Ring Oscillators - Phase Noise - A Complete Synthesizer Design Example (DECT Application).				

SUB SYSTEMS (9)

Data converters in communications, adaptive Filters, equalizers and transceivers

IMPLEMENTATIONS (9)

VLSI architecture for Multitier Wireless System - Hardware Design Issues for a Next generation CDMA System .

LECTURE: 45 PERIODS TUTORIAL: 0 PERIODS PRACTICAL: 0 PERIODS TOTAL: 45 PERIODS

Reference Books:

1. B.Razavi ,*"RF Microelectronics"* , Prentice-Hall ,1998.
2. Bosco H Leung *"VLSI for Wireless Communication"*, Pearson Education, 2002.
3. Thomas H.Lee, *"The Design of CMOS Radio –Frequency Integrated Circuits"*, Cambridge University Press ,2003.
4. Emad N Farag and Mohamed I Elmasry, *"Mixed Signal VLSI Wireless Design - Circuits and Systems"*, Kluwer Academic Publishers, 2000.
5. Behzad Razavi, *"Design of Analog CMOS Integrated Circuits"* McGraw-Hill, 1999.
6. J. Crols and M. Steyaert, *"CMOS Wireless Transceiver Design,"* Boston, Kluwer Academic Pub., 1997.

	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11
CO1	1	-	3	-	2	-	-	-	1	-	-
CO2	1	-	3	1	2	-	-	-	1	-	-
CO3	2	1	-	1	2	-	-	-	1	-	-

Controller of Examinations
Government College of Technology
COIMBATORE - 641 013

16VLPE20 TESTING AND TESTABILITY

L	T	P	C
3	0	0	3

CORE/ ELECTIVE COURSE: Elective**PREREQUISITES:**

- Advanced Digital System Design.

COURSE ASSESSMENT METHODS: Both continuous and semester-end assessment.**COURSE OBJECTIVES:**

- To gain the Basic knowledge on fault modelling , testing and test generation in logic circuits.
- To get exposure to testability approaches and test vector generation algorithms for memory and logic Circuits.
- To Understand the various fault diagnosis methods in logic systems.

COURSE OUTCOMES:**The upon completion of the course students will have**

- CO1:Basic knowledge on fault modelling , testing and test generation in logic circuits.
CO2:Exposure to testability approaches and test vector generation algorithms for memory and logic Circuits.
CO3:Understanding of the various fault diagnosis methods in logic systems..

TOPICS COVERED:**BASICS OF TESTING AND FAULT MODELLING****(9)**

Introduction to Testing - Faults in digital circuits - Modeling of faults - Logical Fault Models – Fault detection - Fault location - Fault dominance - Logic Simulation - Types of simulation - Delay models - Gate level Event-driven simulation.

TEST GENERATION FOR COMBINATIONAL AND SEQUENTIAL CIRCUITS**(9)**

Test generation for combinational logic circuits - Testable combinational logic circuit design –
Test generation for sequential circuits - design of testable sequential circuits.

TESTABILITY**(9)**

Design for Testability - Ad-hoc design - Generic scan based design - Classical scan based design –
System level DFT approach.

SELF-TEST AND TEST ALGORITHMS**(9)**

Built-In Self Test - Test pattern generation for BIST - Circular BIST - BIST Architectures – Testable Memory Design - Test algorithms - Test generation for Embedded RAMs.

FAULT DIAGNOSIS**(9)**

Logic Level Diagnosis - Diagnosis by UUT reduction - Fault Diagnosis for Combinational Circuits - Self-checking design - System Level Diagnosis.

LECTURE: 45 PERIODS TUTORIAL: 0 PERIODS PRACTICAL: 0 PERIODS TOTAL: 45 PERIODS

Reference Books:

1. *M. Abramovici, M.A. Breuer and A.D. Friedman, "Digital Systems and Testable Design", Jaico Publishing House, 11th edition, 2011.*
2. *P.K. Lala, "Digital Circuit Testing and Testability", Academic Press, 2002.*
3. *M.L. Bushnell and V.D. Agrawal, "Essentials of Electronic Testing for Digital, Memory and Mixed- Signal VLSI Circuits", Springer, 2014.*
4. *A.L. Crouch, "Design Test for Digital IC's and Embedded Core Systems", Beijing China Electric Power Press, 2010.*

	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11
CO1	3	3	2	2	3	-	1	-	1	-	1
CO2	2	2	-	2	2	-	-	-	-	-	-
CO3	3	2	-	3	2	-	-	-	-	-	-

**Controller of Examinations
Government College of Technology
COIMBATORE - 641 013**

16VLEE01 PROJECT PHASE I	L 0	T 0	P 12	C 6
COURSE ASSESSMENT METHODS: Both continuous and semester-end assessment.				
COURSE OBJECTIVES:				
<ul style="list-style-type: none"> • To expose the students to take up real time problems and challenges. • To develop confidence to take up a project independently. • To develop an understanding of technical dissertation presentation and writing 				
COURSE OUTCOMES:				
Upon completion of this course, the students will have:				
CO1 : An exposure to take up real time problems and challenges.				
CO2: Confidence to take up a project independently.				
CO3: An understanding of technical dissertation presentation and writing.				

	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11
CO1	1	1	-	2	2	1	2	1	1	2	2
CO2	-	3	3	1	3	2	1	2	2	-	2
CO3	2	2	2	1	3	2	-	2	2	2	2

Controller of Examinations
Government College of Technology,
COIMBATORE - 641 013

16VLEE02 PROJECT PHASE II	L	T	P	C
	0	0	24	12
<i>COURSE ASSESSMENT METHODS:</i> Both continuous and semester-end assessment.				
<i>COURSE OBJECTIVES:</i> To expose the students to take up real time problems and challenges. <ul style="list-style-type: none"> ▪ To develop confidence to take up a project independently. ▪ To develop an understanding of technical dissertation presentation and writing 				
<i>COURSE OUTCOMES:</i> Upon completion of this course, the students will have: CO1 : An exposure to take up real time problems and challenges. CO2: Confidence to take up a project independently. CO3: An understanding of technical dissertation presentation and writing.				

	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11
CO1	1	1	-	2	2	1	2	1	1	2	2
CO2	-	3	3	1	3	2	1	2	2	-	2
CO3	2	2	2	1	3	2	-	2	2	2	2

Controller of Examinations
Government College of Technology
COIMBATORE - 641 013

16VLOC01 SEMINAR AND TECHNICAL WRITING
(Common to Applied Electronics)

L	T	P	C
0	0	2	1

COURSE ASSESSMENT METHODS: Continuous assessment.

COURSE OBJECTIVES:

- To understand the stages of the writing process and apply them to technical and workplace writing tasks.
- To develop confidence to write technical documents in workplace.
- To develop ability to Read, understand and interpret material on technology.

COURSE OUTCOMES:

Upon completion of this course, the students will able to:

- CO1 : Understand the stages of the writing process and apply them to technical and workplace writing tasks.
- CO2 : Produce a set of documents related to technology and writing in the workplace and will have improved ability to write clearly and accurately.
- CO3 : Read, understand and interpret material on technology. They will have an appreciation for some of the ideas, issues and problems involved in writing about technology and in workplace writing.

Controller of Examinations
Government College of Technology
COIMBATORE - 641 013

